## **INTEGRATED CIRCUITS**

# DATA SHEET



# TDA8030; TDA8031 USB smart card reader (OTP or ROM)

**Product specification** 

2003 Jul 04





## **USB** smart card reader (OTP or ROM)

TDA8030; TDA8031

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### USB smart card reader (OTP or ROM)

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#### 1 FEATURES

- 83C51 core with 16 kbytes EPROM (ROM); 256 bytes RAM; 512 bytes AUXRAM; Timer 0,1, 2 and enhanced UART
- Full speed USB interface device which complies with USB 1.1 specification; accessible with MOVX instructions
- Control input and output; 1 generic input and output and 2 generic input end-points
- Compatible with bus powered and suspend mode supply current requirements
- Specific ISO7816 UART; accessible with MOVX instructions for automatic convention processing; variable baud rate through frequency or division ratio programming; error management at character level for T = 0 protocol; extra guard time register
- V<sub>CC</sub> generation (5 or 3 V maximum current 55 mA or 1.8 V maximum current 35 mA) with controlled rise and fall times; current limitation and overload detection at 100 mA
- Cards clock generation with three times synchronous frequency doubling (12, 6, 3 and 1.5 MHz)
- Cards clock STOP HIGH or LOW or 1.25 MHz (from an integrated oscillator) for cards power reduction mode
- Automatic activation and deactivation sequences through an independent sequencer
- Supports the asynchronous protocols T = 0 and T = 1 in accordance with ISO7816 and EMV
- Versatile 24-bit time-out counter for Answer To Reset (ATR) and waiting times processing
- Supports synchronous cards
- Specific Elementary Time Unit (ETU) counter for Block Guard Time (BGT)



- Current limitations on cards contacts and emergency deactivation in case of over consumption or overheating
- Special circuitry for killing spikes during power-on or power-off
- · Supply supervisor for power-on or power-off reset
- High efficiency inductive DC-to-DC converter for V<sub>CC</sub> generation
- · Soft switch on for avoiding current inrush at plug in
- Enhanced ESD protections on cards contacts (6 kV minimum)
- Software library for easy integration within the application.

#### 2 APPLICATIONS

• Smart card readers for PC's or Set Top Boxes.

#### 3 GENERAL DESCRIPTION

The TDA8030; TDA8031 is a bus powered full-speed USB device. All analog and digital functions for an EMV compliant Smart Card Reader are built-in. The embedded 83C51 microcontroller has 16 kbytes EPROM (ROM for TDA8031), 256 bytes RAM and 512 bytes of AUXRAM.

#### 4 ORDERING INFORMATION

| TYPE NUMBER |        | PACKAGE  |          |  |  |  |  |
|-------------|--------|--|----------|--|--|--|--|
| TIPE NOWBER | NAME   | DESCRIPTION  | VERSION  |  |  |  |  |
| TDA8030HL   | LQFP64 | plastic low profile quad flat package; 64 leads; body $10 \times 10 \times 1.4$ mm | SOT314-2 |  |  |  |  |
| TDA8031HL   |        |  |          |  |  |  |  |

## USB smart card reader (OTP or ROM)

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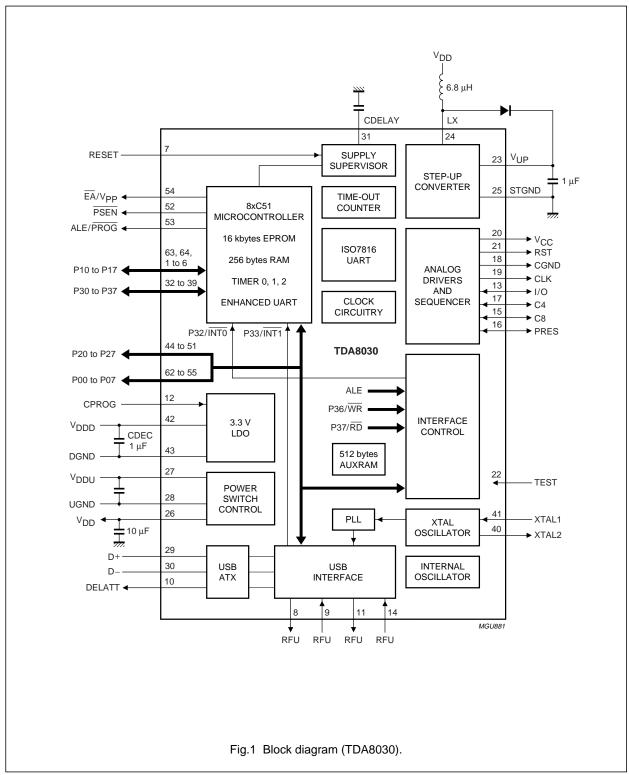
#### 5 QUICK REFERENCE DATA

| SYMBOL           | PARAMETER                             | CONDITIONS   | MIN. | TYP. | MAX. | UNIT |
|------------------|---------------------------------------|--|------|------|------|------|
| V <sub>DDU</sub> | bus supply voltage                    |  | 4.2  | _    | 5.5  | V    |
| I <sub>DDU</sub> | bus supply current                    | $V_{CC} = 5 \text{ V}; I_{CC} = 40 \text{ mA};$<br>$f_{clk} = 6 \text{ MHz}$ | _    | _    | 100  | mA   |
| I <sub>sus</sub> | suspend current                       | card inactive; microcontroller in Power-down mode                            | _    | _    | 500  | μΑ   |
| $V_{CC}$         | card supply voltage                   | including static load; 5 V card  | 4.75 | 5    | 5.25 | V    |
|                  |                                       | with dynamic loads on 200 nF   | 4.60 | _    | 5.40 | V    |
|                  |                                       | including static loads; 3 V card   | 2.85 | 3    | 3.15 | V    |
|                  |                                       | with dynamic loads on 200 nF   | 2.75 | _    | 3.25 | V    |
|                  |                                       | including static loads; 1.8 V card   | 1.64 | 1.8  | 1.96 | V    |
|                  |                                       | with dynamic loads on 200 nF   | 1.62 | _    | 1.98 | V    |
| Icc              | card supply current                   | 5 V card   | _    | _    | -55  | mA   |
|                  |                                       | 3 V card   | _    | _    | -55  | mA   |
|                  |                                       | 1.8 V card   | _    | _    | -35  | mA   |
| I <sub>lim</sub> | current limit on V <sub>CC</sub>      |  | _    | _    | 100  | mA   |
| l <sub>od</sub>  | overload detection on V <sub>CC</sub> |  | _    | _    | 100  | mA   |
| T <sub>amb</sub> | ambient temperature                   |  | -25  | _    | +85  | °C   |

## USB smart card reader (OTP or ROM)

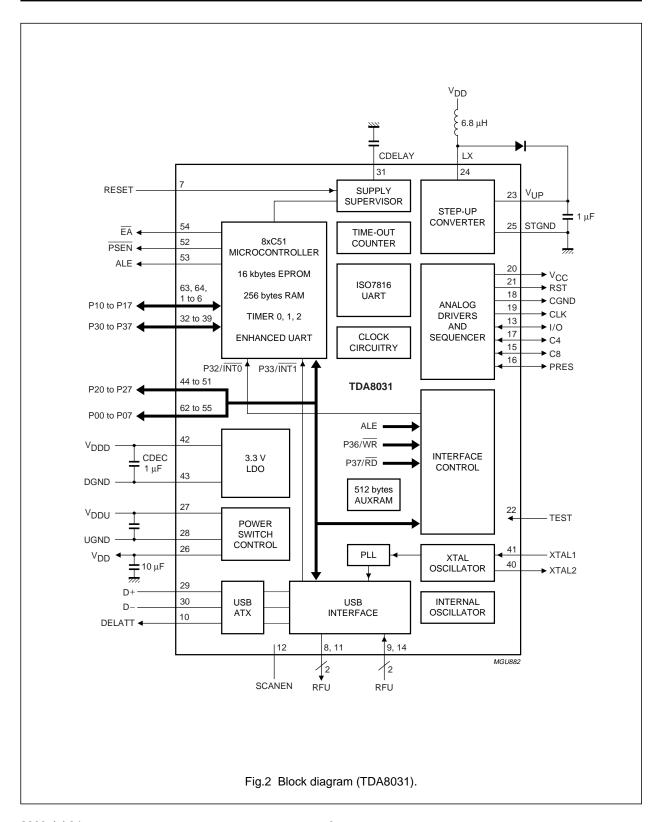
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#### 6 BLOCK DIAGRAM



## USB smart card reader (OTP or ROM)

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## USB smart card reader (OTP or ROM)

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#### 7 PINNING

#### 7.1 TDA8030

| SYMBOL           | PIN | DESCRIPTION  |  |  |  |
|------------------|-----|--|--|--|--|
| P12              | 1   | 8xC51 general purpose I/O port (USB_MC_READY)  |  |  |  |
| P13              | 2   | 8xC51 general purpose I/O port (USB_CLK_EN_N)  |  |  |  |
| P14              | 3   | 8xC51 general purpose I/O port (USB_RESET_N)   |  |  |  |
| P15              | 4   | 8xC51 general purpose I/O port (USB_SOFTCONNECT_EXT)   |  |  |  |
| P16              | 5   | 8xC51 general purpose I/O port (available for the application)   |  |  |  |
| P17              | 6   | 8xC51 general purpose I/O port (available for the application)   |  |  |  |
| RESET            | 7   | reset input (active HIGH, integrated pull-down resistor to ground)   |  |  |  |
| RFU              | 8   | test pin; leave open-circuit in the application  |  |  |  |
| RFU              | 9   | st pin; leave open-circuit in the application  |  |  |  |
| DELATT           | 10  | elayed attachment reference signal output for external pull-up resistor on pin D+ (an internal 5 $k\Omega$ pull-up resistor is already embedded on-chip) |  |  |  |
| RFU              | 11  | test pin; leave open-circuit in the application  |  |  |  |
| CPROG            | 12  | connect to GND within the application; for programming the EPROM connect to $V_{DD}$ as well as pin TEST (pin 22); also used for test purposes           |  |  |  |
| I/O              | 13  | data input/output from the card (C7); 14 kΩ integrated pull-up resistor connected to V <sub>CC</sub>   |  |  |  |
| RFU              | 14  | test pin; leave open-circuit in the application  |  |  |  |
| C8               | 15  | auxiliary I/O for C8 contact; 14 k $\Omega$ integrated pull-up resistor connected to V <sub>CC</sub>   |  |  |  |
| PRES             | 16  | card presence detection input (active HIGH; no need for external pull-up)  |  |  |  |
| C4               | 17  | auxiliary I/O for C4 contact; 14 k $\Omega$ integrated pull-up resistor connected to V <sub>CC</sub>   |  |  |  |
| CGND             | 18  | cards ground (C5) Must be connected to GND   |  |  |  |
| CLK              | 19  | clock output (C30)   |  |  |  |
| V <sub>CC</sub>  | 20  | card supply output voltage (ISO C1 contact); must be decoupled with two 100 nF low ESR ceramic capacitors to CGND  |  |  |  |
| RST              | 21  | cards reset output (C2)  |  |  |  |
| TEST             | 22  | test pin input   |  |  |  |
| V <sub>UP</sub>  | 23  | output of the DC-to-DC converter (decouple with a 1 μF capacitor to STGND)   |  |  |  |
| LX               | 24  | DC-to-DC converter inductor connection (a Schottky diode should be tied to V <sub>UP</sub> )   |  |  |  |
| STGND            | 25  | DC-to-DC converter ground connection   |  |  |  |
| V <sub>DD</sub>  | 26  | soft switched positive supply voltage (decouple with 10 μF capacitor to GND)   |  |  |  |
| V <sub>DDU</sub> | 27  | positive supply voltage for the bus (4.2 to 5.5 V)   |  |  |  |
| UGND             | 28  | bus ground   |  |  |  |
| D+               | 29  | USB D+ data line   |  |  |  |
| D-               | 30  | USB D- data line   |  |  |  |
| CDELAY           | 31  | connection for an external capacitor to ground determining the Power-on reset pulse width (typ 1 ms per 2 nF)  |  |  |  |
| P30/RxD          | 32  | 8xC51 general purpose I/O port/serial input port (available for the application)   |  |  |  |
| P31/TxD          | 33  | 8xC51 general purpose I/O port/serial output port (available for the application)  |  |  |  |
| P32/INT0         | 34  | 8xC51 general purpose I/O port/external interrupt 0 (used by the ISO UART))  |  |  |  |
| P33/INT1         | 35  | 8xC51 general purpose I/O port/external interrupt 1 (used by the USB interface)  |  |  |  |

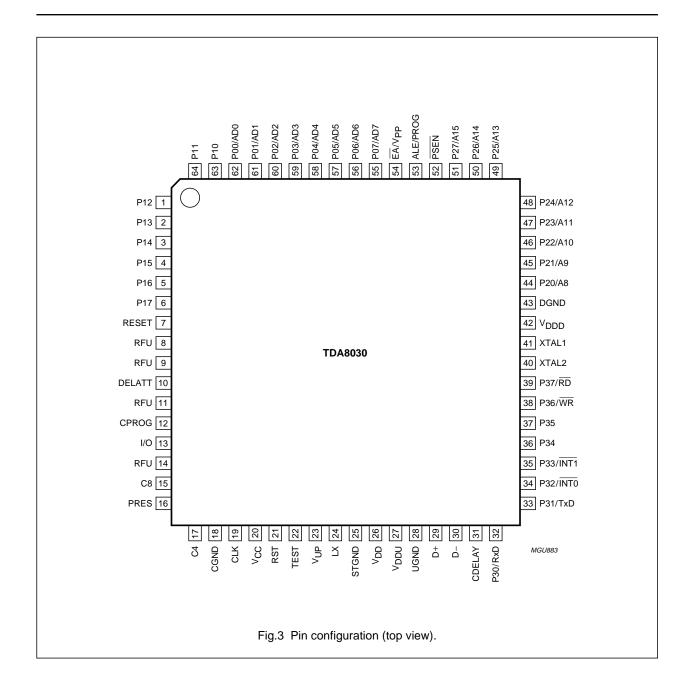
## USB smart card reader (OTP or ROM)

| TDA  | <del>1</del> 8030: | TDA  | \8031 |
|------|--------------------|------|-------|
| . –, | 10000,             | . –, |       |

| SYMBOL             | PIN | DESCRIPTION  |
|--------------------|-----|--|
| P34                | 36  | 8xC51 general purpose I/O port (USB_SUSPEND in TDA8030)  |
| P35                | 37  | 8xC51 general purpose I/O port (USB_WAKEUP_N in TDA8031)   |
| P36/WR             | 38  | external data memory write strobe  |
| P37/RD             | 39  | external data memory read strobe   |
| XTAL2              | 40  | 12 MHz crystal output; leave open-circuit if an external clock is used   |
| XTAL1              | 41  | external 12 MHz crystal connection or input for an external clock signal   |
| $V_{DDD}$          | 42  | 3.3 V regulated digital supply voltage output (decouple with 1 μF ceramic capacitor)   |
| DGND               | 43  | Digital ground   |
| P20/A8             | 44  | 8xC51 general purpose I/O port/address 8 (available for the application)   |
| P21/A9             | 45  | 8xC51 general purpose I/O port/address 9 (available for the application)   |
| P22/A10            | 46  | 8xC51 general purpose I/O port/address 10 (available for the application)  |
| P23/A11            | 47  | 8xC51 general purpose I/O port/address 11 (available for the application)  |
| P24/A12            | 48  | 8xC51 general purpose I/O port/address 12 (available for the application)  |
| P25/A13            | 49  | 8xC51 general purpose I/O port/address 13 (USB_MP_C)   |
| P26/A14            | 50  | 8xC51 general purpose I/O port/address 14 (USB_MP_SEL)   |
| P27/A15            | 51  | 8xC51 general purpose I/O port/address 15 (ISO_UART_CS)  |
| PSEN               | 52  | Program Store Enable: read strobe to external program memory when executing code from the external program memory; $\overline{PSEN}$ is activated twice each machine cycle except when two $\overline{PSEN}$ activations are skipped during each access to external data memory. $\overline{PSEN}$ is not activated during fetches from internal program memory.   |
| ALE/PROG           | 53  | Address Latch Enable/Program Pulse: output pulse for latching the low byte of the address during an access to external memory. In normal operation ALE is emitted at a constant rate of 1/6 the oscillator frequency and can be used for external timing or clocking. It should be noted that one ALE pulse is skipped during each access to external data memory. This pin is also the program pulse input (PROG) during EPROM programming. ALE can be disabled by setting SFR Auxiliary0. With this bit set ALE will be active only during a MOVX instruction.       |
| ĒĀ/V <sub>PP</sub> | 54  | External Access Enable/Programming Supply Voltage: $\overline{EA}$ must be externally held LOW to enable the device to fetch code from external program memory locations starting with 0000H. If $\overline{EA}$ is held HIGH the device executes from internal program memory unless the program counter contains an address greater than 3FFFH (16 kbytes boundary). This pin also receives the 12.75 V programming supply voltage (V <sub>PP</sub> ) during EPROM programming. If security bit 1 is programmed $\overline{EA}$ will be internally latched on reset. |
| P07/AD7            | 55  | 8xC51 general purpose I/O port/address/data 7  |
| P06/AD6            | 56  | 8xC51 general purpose I/O port/address/data 6  |
| P05/AD5            | 57  | 8xC51 general purpose I/O port/address/data 5  |
| P04/AD4            | 58  | 8xC51 general purpose I/O port/address/data 4  |
| P03/AD3            | 59  | 8xC51 general purpose I/O port/address/data 3  |
| P02/AD2            | 60  | 8xC51 general purpose I/O port/address/data 2  |
| P01/AD1            | 61  | 8xC51 general purpose I/O port/address/data 1  |
| P00/AD0            | 62  | 8xC51 general purpose I/O port/address/data 0  |
| P10                | 63  | 8xC51 general purpose I/O port (USB_INT_MASK)  |
| P11                | 64  | 8xC51 general purpose I/O port (USB_SOFTCONNECT_INT)   |

## USB smart card reader (OTP or ROM)

TDA8030; TDA8031



## USB smart card reader (OTP or ROM)

TDA8030; TDA8031

#### 7.2 TDA8031

| SYMBOL           | PIN | DESCRIPTION   |  |  |  |  |
|------------------|-----|---|--|--|--|--|
| P12              | 1   | 8xC51 general purpose I/O port (USB_MC_READY)   |  |  |  |  |
| P13              | 2   | 8xC51 general purpose I/O port (USB_CLK_EN_N)   |  |  |  |  |
| P14              | 3   | 8xC51 general purpose I/O port (USB_RESET_N)  |  |  |  |  |
| P15              | 4   | 8xC51 general purpose I/O port (USB_SOFTCONNECT_EXT)  |  |  |  |  |
| P16              | 5   | 8xC51 general purpose I/O port (available for the application)  |  |  |  |  |
| P17              | 6   | C51 general purpose I/O port (available for the application)  |  |  |  |  |
| RESET            | 7   | et input (active HIGH, integrated pull-down resistor to ground)   |  |  |  |  |
| RFU              | 8   | test pin; leave open-circuit in the application   |  |  |  |  |
| RFU              | 9   | test pin; leave open-circuit in the application   |  |  |  |  |
| DELATT           | 10  | elayed attachment reference signal output for external pull-up resistor on pin D+ (an internate by pull-up resistor is already embedded in the chip)  |  |  |  |  |
| RFU              | 11  | test pin; leave open-circuit in the application   |  |  |  |  |
| SCANEN           | 12  | connect to GND within the application; for programming the EPROM connect to V <sub>DD</sub> as well as pin TEST (pin 22); also used for test purposes |  |  |  |  |
| I/O              | 13  | data input/output from the card (C7); 14 kΩ integrated pull-up resistor connected to V <sub>CC</sub>  |  |  |  |  |
| RFU              | 14  | test pin; leave open-circuit in the application   |  |  |  |  |
| C8               | 15  | auxiliary I/O for C8 contact; 14 kΩ integrated pull-up resistor connected to V <sub>CC</sub>  |  |  |  |  |
| PRES             | 16  | card presence detection input (active HIGH; no need for external pull-up)   |  |  |  |  |
| C4               | 17  | auxiliary I/O for C4 contact; 14 kΩ integrated pull-up resistor connected to V <sub>CC</sub>  |  |  |  |  |
| CGND             | 18  | cards ground (C5) Must be connected to GND  |  |  |  |  |
| CLK              | 19  | clock output (C30)  |  |  |  |  |
| V <sub>CC</sub>  | 20  | card supply output voltage (ISO C1 contact); must be decoupled with two 100 nF low ESR ceramic capacitors to CGND                                     |  |  |  |  |
| RST              | 21  | cards reset output (C2)   |  |  |  |  |
| TEST             | 22  | test pin input  |  |  |  |  |
| V <sub>UP</sub>  | 23  | output of the DC-to-DC converter (decouple with a 1 μF capacitor to STGND)  |  |  |  |  |
| LX               | 24  | DC-to-DC converter inductor connection (a Schottky diode should be tied to V <sub>UP</sub> )  |  |  |  |  |
| STGND            | 25  | DC-to-DC converter ground connection  |  |  |  |  |
| V <sub>DD</sub>  | 26  | soft switched positive supply voltage (decouple with 10 μF capacitor to GND)  |  |  |  |  |
| V <sub>DDU</sub> | 27  | positive supply voltage for the bus (4.2 to 5.5 V)  |  |  |  |  |
| UGND             | 28  | bus ground  |  |  |  |  |
| D+               | 29  | USB D+ data line  |  |  |  |  |
| D-               | 30  | USB D- data line  |  |  |  |  |
| CDELAY           | 31  | connection for an external capacitor to ground determining the Power-on reset pulse width (typ 1 ms per 2 nF)   |  |  |  |  |
| P30/RxD          | 32  | 8xC51 general purpose I/O port/serial input port (available for the application)  |  |  |  |  |
| P31/TxD          | 33  | 8xC51 general purpose I/O port/serial output port (available for the application)   |  |  |  |  |
| P32/INT0         | 34  | 8xC51 general purpose I/O port/external interrupt 0 (used by the ISO UART))   |  |  |  |  |
| P33/INT1         | 35  | 8xC51 general purpose I/O port/external interrupt 1 (used by the USB interface)   |  |  |  |  |
| P34              | 36  | 8xC51 general purpose I/O port (USB_SUSPEND in TDA8030)   |  |  |  |  |

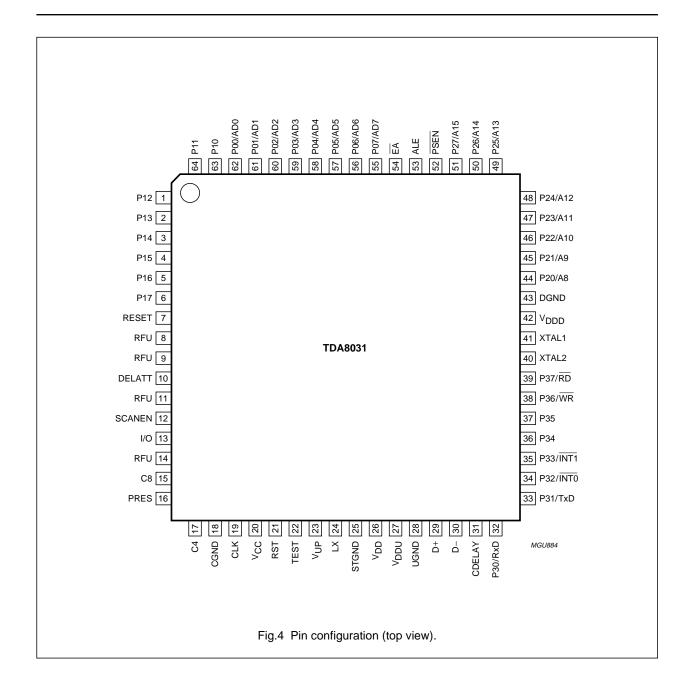
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| SYMBOL           | PIN | DESCRIPTION  |
|------------------|-----|--|
| P35              | 37  | 8xC51 general purpose I/O port (USB_WAKEUP_N in TDA8030)   |
| P36/WR           | 38  | external data memory write strobe  |
| P37/RD           | 39  | external data memory read strobe   |
| XTAL2            | 40  | 12 MHz crystal output; leave open-circuit if an external clock is used   |
| XTAL1            | 41  | external 12 MHz crystal connection or input for an external clock signal   |
| V <sub>DDD</sub> | 42  | 3.3 V regulated digital supply voltage output (decouple with 1 μF ceramic capacitor)   |
| DGND             | 43  | Digital ground   |
| P20/A8           | 44  | 8xC51 general purpose I/O port/address 8 (available for the application)   |
| P21/A9           | 45  | 8xC51 general purpose I/O port/address 9 (available for the application)   |
| P22/A10          | 46  | 8xC51 general purpose I/O port/address 10 (available for the application)  |
| P23/A11          | 47  | 8xC51 general purpose I/O port/address 11 (available for the application)  |
| P24/A12          | 48  | 8xC51 general purpose I/O port/address 12 (available for the application)  |
| P25/A13          | 49  | 8xC51 general purpose I/O port/address 13 (USB_MP_C)   |
| P26/A14          | 50  | 8xC51 general purpose I/O port/address 14 (USB_MP_SEL)   |
| P27/A15          | 51  | 8xC51 general purpose I/O port/address 15 (ISO_UART_CS)  |
| PSEN             | 52  | Program Store Enable: read strobe to external program memory when executing code from the external program memory; $\overline{PSEN}$ is activated twice each machine cycle except when two $\overline{PSEN}$ activations are skipped during each access to external data memory. $\overline{PSEN}$ is not activated during fetches from internal program memory.   |
| ALE              | 53  | Address Latch Enable/Program Pulse: output pulse for latching the low byte of the address during an access to external memory. In normal operation ALE is emitted at a constant rate of 1/6 the oscillator frequency and can be used for external timing or clocking. It should be noted that one ALE pulse is skipped during each access to external data memory. This pin is also the program pulse input (PROG) during EPROM programming. ALE can be disabled by setting SFR Auxiliary0. With this bit set ALE will be active only during a MOVX instruction.       |
| EA               | 54  | External Access Enable/Programming Supply Voltage: $\overline{EA}$ must be externally held LOW to enable the device to fetch code from external program memory locations starting with 0000H. If $\overline{EA}$ is held HIGH the device executes from internal program memory unless the program counter contains an address greater than 3FFFH (16 kbytes boundary). This pin also receives the 12.75 V programming supply voltage (V <sub>PP</sub> ) during EPROM programming. If security bit 1 is programmed $\overline{EA}$ will be internally latched on reset. |
| P07/AD7          | 55  | 8xC51 general purpose I/O port/address/data 7  |
| P06/AD6          | 56  | 8xC51 general purpose I/O port/address/data 6  |
| P05/AD5          | 57  | 8xC51 general purpose I/O port/address/data 5  |
| P04/AD4          | 58  | 8xC51 general purpose I/O port/address/data 4  |
| P03/AD3          | 59  | 8xC51 general purpose I/O port/address/data 3  |
| P02/AD2          | 60  | 8xC51 general purpose I/O port/address/data 2  |
| P01/AD1          | 61  | 8xC51 general purpose I/O port/address/data 1  |
| P00/AD0          | 62  | 8xC51 general purpose I/O port/address/data 0  |
| P10              | 63  | 8xC51 general purpose I/O port (USB_INT_MASK)  |
| P11              | 64  | 8xC51 general purpose I/O port (USB_SOFTCONNECT_INT)   |
|                  |     | · · · · · · · · · · · · · · · · · · ·  |

## USB smart card reader (OTP or ROM)

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#### 8 FUNCTIONAL DESCRIPTION

Throughout this specification, it is assumed that the reader is aware of ISO7816 and USB norms terminology.

#### 8.1 ISO7816 UART AND ASSOCIATED LOGIC

This section describes how the integrated ISO7816 UART operates, how it can be programmed by means of its control registers and how it is internally interfaced to the embedded microcontroller.

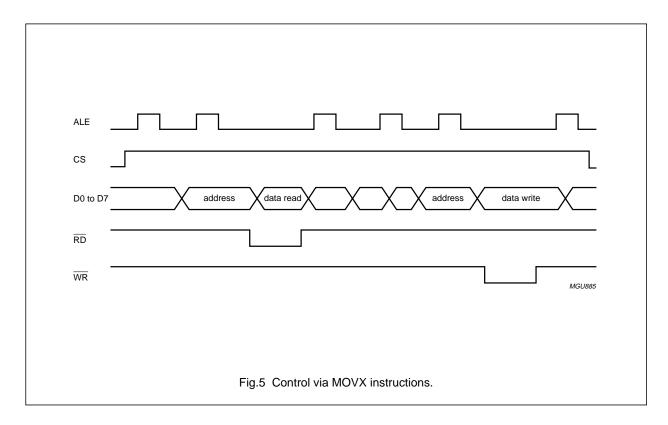
#### 8.1.1 INTERFACE CONTROL

The ISO7816 UART can be controlled via an 8-bit parallel bus. This bus is directly (internally) connected to Port 0 (P07 to P00) of the embedded 83C51 microcontroller.

The registers within the ISO7816 UART may be written to or read from by using the standard 83C51 MOVX instructions. It should be noted, that only if pin P27/A15 is HIGH, can the UART be accessed.

When pin P27/A15 is HIGH, the demultiplexing of address and data is done internally by means of the ALE signal. A LOW pulse on pin P37/RD enables the selected register to be read, a LOW pulse on pin P36/WR enables the selected register to be written to.

The ISO UART interrupt line is directly connected to the microcontrollers External Interrupt 0 input, pin P32/INT0. For that reason, the External Interrupt 0 of the 83C51 microcontroller must be enabled to ensure a proper function



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#### 8.1.2 CONTROL REGISTERS

The TDA8030; TDA8031 has 1 analog interface for 7 contacts cards. The data to and from the cards is fed into an ISO UART.

The Card Select Register (CSR) contains one bit for resetting the ISO UART (RIU, active LOW). This bit is reset after power-on and must be set HIGH before starting any operation. It may be reset by software when necessary.

The following dedicated registers enable the parameters of the ISO UART and the ETU counters to be set:

- Programmable Divider Register (PDR)
- Guard Time Register (GTR)
- Two UART Control Registers (UCR1 and UCR2)
- Clock Configuration Register (CCR)
- Time-Out Configuration Register (TOCR)
- Three Time-Out Registers (TOR1, TOR2 and TOR3).

There is also a dedicated Power Control Register (PCR) for controlling the power to the card.

When the specific parameters of the card have been programmed, the UART may be used with the following registers:

- UART Receive Register (URR)
- UART Transmit Register (UTR)
- UART Status Register (USR)
- Mixed Status Register (MSR).

In the reception mode, a FIFO of 1 to 8 characters may be used and is configured with the FIFO Control Register (FCR). This register may also be used for programming an automatic repetition of NAKed characters in the transmission mode.

The Hardware Status Register (HSR) gives the status of the supply voltage, of the hardware protections and of the card movements.

The USR and HSR give interrupts on pins INT when some of their bits have been changed.

The MSR does not give interrupts and may be used in the polling mode for some operations; when this is the case, the bit Transmit Buffer Empty/Receive Buffer Full (TBE/RBF) within the USR may be masked.

A 24-bit time-out counter may be started to provide an interrupt after a number of ETUs programmed in time-out registers TOR1, TOR2 and TOR3. This will help the microcontroller when processing different real-time tasks (ATR, WWT and BWT etc.), mainly if the microcontrollers and cards clock are asynchronous.

This counter is configured with a Time-Out Counter Configuration register (TOCC) and may be used as a 24-bit or as a 16 + 8-bit counter. Each counter may be set to start counting once data has been written, or on detection of a start bit on the I/O or as autoreload.

#### 8.1.3 GENERAL REGISTERS

#### 8.1.3.1 Card select register

The Card Select Register (CSR) is used for resetting the ISO UART.

The bit Reset ISO UART  $(\overline{RIU})$  must be set to logic 1 by software before any action on the UART. When set to logic 0, this bit resets a large part of the UART registers to their default value; see Table 1. A minimum pulse of 10 ns is needed on  $\overline{RIU}$ . This bit must be reset before any new activation.

Table 1 Card select register (address 00H; write and read); note 1

| 7 | 6 | 5 | 4 | 3   | 2 | 1 | 0 |
|---|---|---|---|-----|---|---|---|
| _ | _ | _ | - | RIU |   | _ | _ |

#### Note

1. All bits are cleared after reset.

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#### 8.1.3.2 Hardware status register

The Hardware Status Register (HSR) gives the status of the chip after a hardware problem has been detected.

Table 2 Hardware Status Register (address 0FH; read only); note 1

| 7 | 6 | 5    | 4    | 3 | 2   | 1 | 0   |
|---|---|------|------|---|-----|---|-----|
| _ | _ | PRTL | SUPL | _ | PRL | _ | PTL |

#### Note

1. All bits are cleared after reset.

Table 3 Description of the HSR bits

| BIT     | SYMBOL | DESCRIPTION   |
|---------|--------|---|
| 7 and 6 | -      | not used  |
| 5       | PRTL   | Protection 1: Bit PRTL = 1 when a default has been detected on card reader. Bit PRTL is the OR function of the protection on pins $V_{CC}$ and RST. |
| 4       | SUPL   | Supervisor Latch: Bit SUPL = 1 when the supervisor has been activated.  |
| 3       | _      | not used  |
| 2       | PRL    | Presence Latch: Bit PRL = 1 when a change has occurred on pin PRES.   |
| 1       | _      | not used  |
| 0       | PTL    | Overheating: Bit PTL = 1 if overheating has occurred.   |

When either bits PRTL, PRL or PTL is logic 1, then pin  $\overline{\text{INTO}}$  is LOW. The bits having caused the interrupt are cleared when the HSR has been readout (2 ×  $f_{\text{int}}$  cycles after the rising edge of  $\overline{\text{RD}}$ ).

At power-on, or after a supply voltage drop-out, SUPL is set and  $\overline{\text{INT0}}$  is LOW.  $\overline{\text{INT0}}$  will return HIGH at the end of the internal Power-on reset pulse defined by the value of the capacitor connected to pin CDELAY. SUPL will be reset only after a status register readout outside the Power-on reset pulse; see Fig.8.

In the event of emergency deactivation (by PRTL, SUPL, PRL and PTL), bit START will be automatically reset by hardware.

#### 8.1.3.3 Time-out registers

The three Time-Out Registers TOR1, TOR2 and TOR3 form a programmable 24-bit ETU counter, or two independant counters (one 16-bit and one 8-bit).

The value to load in TOR1, TOR2 and TOR3 is the number of ETUs to count.

Table 4 Time-out register 1 (address 09H; write only); note 1

| 7    | 6    | 5    | 4    | 3    | 2    | 1    | 0    |
|------|------|------|------|------|------|------|------|
| TOL7 | TOL6 | TOL5 | TOL4 | TOL3 | TOL2 | TOL1 | TOL0 |

#### Note

1. All bits are cleared after reset.

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Table 5 Time-out register 2 (address 0AH; write only); note 1

| 7     | 6     | 5     | 4     | 3     | 2     | 1    | 0    |
|-------|-------|-------|-------|-------|-------|------|------|
| TOL15 | TOL14 | TOL13 | TOL12 | TOL11 | TOL10 | TOL9 | TOL8 |

#### Note

1. All bits are cleared after reset.

Table 6 Time-out register 3 (address 0BH; write only); note 1

| 7     | 6     | 5     | 4     | 3     | 2     | 1     | 0     |
|-------|-------|-------|-------|-------|-------|-------|-------|
| TOL23 | TOL22 | TOL21 | TOL20 | TOL19 | TOL18 | TOL17 | TOL16 |

#### Note

1. All bits are cleared after reset.

#### 8.1.3.4 Time-out configuration register

The Time-Out Configuration register (TOCR) is used for setting different configurations of the time-out counter according to Table 8; all other configurations are undefined.

The timers can operate in 3 modes:

- 1. Software triggered
- 2. Start bit triggered
- 3. Autoreload.

Table 7 Time-out configuration register (address 08H; read and write); note 1

| 7    | 6    | 5    | 4    | 3    | 2    | 1    | 0    |
|------|------|------|------|------|------|------|------|
| TOC7 | TOC6 | TOC5 | TOC4 | TOC3 | TOC2 | TOC1 | TOC0 |

#### Note

1. All bits are cleared after reset.

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 Table 8
 Time-out counter configuration

| TOC VALUE | OPERATING MODE  |
|-----------|---|
| 00H       | All counters are stopped.   |
| 05H       | Counters 2 and 3 are stopped; counter 1 continues to operate in autoreload mode.  |
| 61H       | Counter 1 is stopped and counters 3 and 2 form a 16-bit counter. Counting the value stored in TOR3 and TOR2 is started after 6H is written in the TOCR. An interrupt is given and bit TO3 is set within the USR when the terminal count is reached. The counter is stopped by writing 00H in the TOCR and will be stopped before reloading a new value in TOR2 and TOR3.  |
| 65H       | Counter 1 is an 8-bit autoreload counter and counters 3 and 2 form a 16-bit counter. Counter 1 starts counting the content of TOR1 on the first START bit (reception or transmission) detected on I/O after 65H is written in the TOCR. When Counter 1 reaches its terminal count, an interrupt is given, bit TO1 in the USR is set and the counter automatically restarts the same count until it is stopped. It is not allowed to change the content of TOR1 during a count. Counters 3 and 2 are wired as a single 16-bit counter and starts counting the value TOR3 and TOR2 when 65H is written in the TOCR. When the counter reaches its terminal count, an interrupt is given and bit TO3 is set within the USR. Both counters are stopped when 00H is written in the TOCR. Counters 3 and 2 will be stopped by writing 05H in the TOCR before reloading a new value in TOR2 and TOR3. |
| 68H       | Counters 3, 2 and 1 are wired as a single 24-bit counter. Counting the value stored in TOR3, TOR2 and TOR1 is started after 68H is written in the TOCR. The counter is stopped by writing 00H in the TOCR. It is not allowed to change the content of TOR3, TOR2 and TOR1 within a count.   |
| 7CH       | Counters 3, 2 and 1 are wired as a single 24-bit counter. Counting the value stored in TOR3, TOR2 and TOR1 on the first start bit detected on I/O (reception or transmission) after the value has been written. It is possible to change the content of TOR3, TOR2 and TOR1 during a count; the current count will not be affected and the new count value will be taken into account at the next start bit. The counter is stopped by writing 00H in the TOCR. In this configuration TOR3, TOR2 and TOR1 must not be all zero.   |
| 85H       | Same as 05H, except that all the counters will be stopped at the end of the 12th ETU following the first received start bit detected after 85H has been written in the TOCR.  |
| E5H       | Same configuration as TOCR = 65H, except that Counter 1 will be stopped at the end of the 12th ETU following the first start bit detected after E5H has been written in the TOCR.   |

The time-out counter is very useful for processing the clock counting during ATR, the Work Waiting Time (WWT) or the waiting times defined in T = 1 protocol. The 200 and 384 clock counter used during ATR is done by hardware when Start Session is set, a specific hardware takes care of BGT in T = 1 protocol and a specific register is present for processing the extra guard time.

It is not allowed to change the content of the TOR registers whilst a counter is in software triggered mode, or in autoreload mode. In these modes, it is mandatory to stop the counters (TOCR = 00H or 05H) before updating the count value in the TOR registers. In start bit triggered mode, the value may be changed at any time; the new count value will be taken into account on the next start bit.

The minimum time interval between 2 successive write operations in TOCR is  $\frac{2}{31}$  or  $\frac{2}{32}$  ETU.

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It is obvious that the counters may only be used once the card has been activated.

Detailed examples of how to use these specific timers can be found in Application Note "AN01012".

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#### 8.1.4 ISO UART REGISTERS

#### 8.1.4.1 UART transmit register

When the microcontroller wants to transmit a character to the card, it writes the data in direct convention in this register.

The transmission:

- Starts at the end of this writing (2 clock cycles after the rising edge of WR) if the previous character has been transmitted and if the extra guard time has expired
- Starts at the end of the extra guard time if this one has not expired
- Starts at 13.5 ETU in manual mode and 15 ETU in automatic mode if the previous character has been NAKed by the card; see Section 8.1.4.4

 Does not start if the transmission of the previous character is not completed.

When the transmission is completed:

- In T = 0, bit TBE is set at 11.5 ETU, and bit PE in the event of parity error
- In T = 1, bit TBE is set at 10.5 ETU.

In the event of synchronous cards (bit SAN set within UCR2), UT0 is only relevant and is copied on the I/O of the card. It is possible to write within the UTR before setting the transmission mode, which may be useful in some cases.

Table 9 UART transmit register (address 0DH; write only); note 1

| 7   | 6   | 5   | 4   | 3   | 2   | 1   | 0   |
|-----|-----|-----|-----|-----|-----|-----|-----|
| UT7 | UT6 | UT5 | UT4 | UT3 | UT2 | UT1 | UT0 |

#### Note

1. All bits are cleared after reset.

#### 8.1.4.2 UART receive register

When the microcontroller wants to read data from the card, it reads it from this register in direct convention.

In the event of synchronous cards, only UR0 is relevant and is a copy of the state of the card I/O.

In the event of parity error:

- The bit PE in the status register USR is set at 10.5 ETU and INTO falls LOW
- In protocol T = 0, the received byte is not stored in URR;
   In protocol T = 1, the received byte is stored.

In both protocols, when a character has been stored, then the bit RBF in the status register USR is set at 10.5 ETU. This bit is reset when the character has been read from the URR.

When the URR is empty, then bit FE (in the MSR) is set as long as no character has been received.

Table 10 UART receive register (address 0DH; read only); note 1

| 7   | 6   | 5   | 4   | 3   | 2   | 1   | 0   |
|-----|-----|-----|-----|-----|-----|-----|-----|
| UR7 | UR6 | UR5 | UR4 | UR3 | UR2 | UR1 | UR0 |

#### Note

1. All bits are cleared after reset.

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#### 8.1.4.3 Mixed status register

The Mixed Status Register (MSR) relates the status of the cards presence contact PRES, the BGT counter, the FIFO empty indication, the transmit/receive ready indicator TBE/RBF and the completion of clock switching to or from ½ fint.

Table 11 Mixed status register (address 0CH; read only); note 1

| 7     | 6  | 5   | 4 | 3 | 2  | 1 | 0       |
|-------|----|-----|---|---|----|---|---------|
| CLKSW | FE | BGT | _ | _ | PR | _ | TBE/RBF |

#### Note

1. Bits TBE/RBF are cleared after reset; bit FE is set after reset.

Table 12 Description of the MSR bits; note 1

| BIT     | SYMBOL  | DESCRIPTION   |
|---------|---------|---|
| 7       | CLKSW   | Clock switch: Bit CLKSW = 1 when the TDA8030; TDA8031 has performed a required clock switch from $\frac{1}{2}f_{int}$ and is reset when the TDA8030; TDA8031 has performed a required clock switch from $\frac{1}{2}f_{int}$ to $\frac{1}{2}f_{int}$ to $\frac{1}{2}f_{int}$ , the application will wait until this bit has been set or reset before setting the microcontroller in power-down mode or restarting sending commands after leaving power-down mode (only needed when the clock is not stopped). This bit is also reset by $\overline{RIU}$ and at power-on. |
| 6       | FE      | FIFO Empty: Bit FE = 1 when the reception FIFO is empty; it is reset when at least one character has been loaded in the FIFO.   |
| 5       | BGT     | Block Guard Time: In T = 1 protocol, the bit BGT is linked with a 22 ETU counter, which is started at every start bit on the I/O. If the count is finished before the next start bit, then bit BGT is set. This helps to ensure that the card has not answered before 22 ETU after the last transmitted character, or that the reader is not transmitting a character before 22 ETU after the last received character.  |
|         |         | In T = 0 protocol, the bit BGT is linked to a 16 ETU counter, which is started at every start bit on the I/O. If the count is finished before the next start bit, then the bit BGT is set. This helps to ensure that the reader is not transmitting too early after the last received character.  |
| 4 and 3 |         | not used  |
| 2       | PR      | Presence: Bit PR = 1 when the card is present.  |
| 1       | _       | not used  |
| 0       | TBE/RBF | Transmit Buffer Empty/Receive Buffer Full: Bit TBE/RBF = 1 when:  |
|         |         | Changing from reception mode to transmission mode   |
|         |         | A character has been transmitted by the UART (except when a character has been transmitted free of parity error while LCT = 1)  |
|         |         | The reception buffer is full.   |
|         |         | Bit TBE/RBF = 0 after power-on, or after one of the following:  |
|         |         | When the bit RIU is reset   |
|         |         | When a character has been written into register UTR   |
|         |         | When the character has been read in register URR  |
|         |         | When changing from transmission mode to reception mode.   |

#### Note

1. No bits within the MSR have an effect on INTO.

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#### 8.1.4.4 FIFO control register

The FIFO Control Register (FCR) relates the parity error count and the FIFO length.

Table 13 FIFO control register (address 0CH; write only); note 1

| 7 | 6    | 5    | 4    | 3 | 2   | 1   | 0   |
|---|------|------|------|---|-----|-----|-----|
| _ | PEC2 | PEC1 | PEC0 | _ | FL2 | FL1 | FL0 |

#### Note

1. All bits are cleared after reset.

Table 14 Description of the FCR bits

| BIT    | SYMBOL          | DESCRIPTION  |
|--------|-----------------|--|
| 7      | _               | not used   |
| 6 to 4 | PEC2 to<br>PEC0 | Parity Error Count: PEC2, PEC1 and PEC0 determine the number of parity errors before setting the bit PE within the USR and pulling INTO LOW; 000 means that only one parity error has occurred and bit PE is set.            |
|        |                 | The value 000 indicates that if only one parity error has occurred bit PE is set; the value 111 indicates that PE will be set after 8 parity errors.   |
|        |                 | In protocol T = 0:   |
|        |                 | If a correct character is received before the programmed error number is reached the error counter will be reset   |
|        |                 | If the programmed number of allowed parity errors is reached, bit PE in the USR will be set as long as the USR has not been read   |
|        |                 | If a transmitted character has NAKed by the card, then the TDA8030; TDA8031 will automatically re-transmit it a number of times equal to the value programmed in PEC2, PEC1 and PEC0. The character will be resent at 15 ETU |
|        |                 | • In transmission mode, if bits PEC2, PEC1 and PEC0 are at logic 0, then the automatic re-transmission is invalidated; the character manually rewritten in the UTR will start at 13.5 ETU.                                   |
|        |                 | In protocol T = 1:   |
|        |                 | The error counter has no action; bit PE is set at the first incorrectly received character.  |
| 3      | _               | not used   |
| 2 to 0 | FL2 to FL0      | FIFO Length: Bits FL2, FL1 and FL0 determine the depth of the FIFO:  |
|        |                 | • 000 = length 1   |
|        |                 | • 111 = length 8   |

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#### 8.1.4.5 UART status register

The UART Status Register (USR) is used by the microcontroller to monitor the activity of the ISO UART and of the time-out counter.

Table 15 UART status register (address 0EH; read only); note 1

| 7   | 6 | 5   | 4  | 3  | 2   | 1   | 0       |
|-----|---|-----|----|----|-----|-----|---------|
| TO3 | _ | TO1 | EA | PE | OVR | FER | TBE/RBF |

#### Note

1. All bits are cleared after reset.

Table 16 Description of the USR bits

| BIT | SYMBOL  | DESCRIPTION  |
|-----|---------|--|
| 7   | TO3     | Time-Out counter 3: Bit TO3 = 1 when counter 3, or counters 3 + 2 or counters 3 + 2 + 1 have reached their terminal count.   |
| 6   | _       | not used   |
| 5   | TO1     | Time-Out counter 1: Bit TO1 = 1 when counter 1 has reached its terminal count.   |
| 4   | EA      | Early Answer: When bit RST is LOW, EA is HIGH if the first start bit on the I/O during ATR has been detected between 200 and 384 clock pulses (all activities on the I/O during the first 200 clock pulses with RST LOW are not taken into account). When RST is HIGH, EA is HIGH if a start bit has been detected before the 384th clock pulse. These two features are reinitialized at each toggling of RST. |
| 3   | PE      | Parity Error: In T = 0 protocol, PE = 1 if the UART has detected a number of received characters with parity error equal to the number written in PEC2, PEC1 and PEC0 or if a transmitted character has been NAKed by the card a number of times equal to the value programmed in PEC2, 1 and 0. It is set at 10.5 ETU in reception mode and at 11.5 ETU in transmission mode.                                 |
|     |         | In $T=0$ protocol, a character received with a parity error is not stored in the FIFO, the card is supposed to repeat this character. In $T=1$ protocol, a character with a parity error is stored in the FIFO and the parity error counter is not operating.  |
| 2   | OVR     | Overrun: Bit OVR = 1 if the UART has received a new character while the URR was full. In this case, at least one character has been lost. OVR is set at 10.5 ETU.  |
| 1   | FER     | Framing Error: Bit FER = 1 when the I/O was not in high-impedance state at 10.25 ETU after a start bit. It is reset when the USR has been read-out.  |
| 0   | TBE/RBF | Transmission Buffer Empty/Reception Buffer Full: Bits TBE and RBF share the same bit within the USR. When in transmission mode the relevant bit is TBE; when in reception mode it is RBF.  |
|     |         | Bit TBE = 1 when the UART is in transmission mode and when the microcontroller may write the next character to transmit in the UTR. It is reset when the microcontroller has written data in the Transmit Register, or when the bit T/R within UCR1 has been reset either automatically or by software. TBE is set at 11.5 ETU in T = 0 protocol and at 10.5 ETU in T = 1 protocol.                            |
|     |         | Bit RBF = 1 when the FIFO is full. The microcontroller may read some of the characters in the URR, which clears the bit RBF. Bit RBF is also reset when entering the reception mode and is set at 10.5 ETU.  |

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If any of the status bits FER, OVR, PE, EA, TO1 or TO3 are set, then  $\overline{INT0}$  is LOW. The bit having caused the interrupt is reset  $2\times f_{int}$  cycles after the rising edge of  $\overline{RD}$  during a read operation of the USR. If TBE/RBF is set and if the mask bit DISTBE/RBF within UCR2 is not set, then  $\overline{INT0}$  is also LOW. TBE/RBF is reset 2 clock cycles after data has been written into the UTR, or 2 clock cycles after data has been read from the URR, or when changing from transmission mode to reception mode if the FIFO had not been left full when going to transmission mode. If the Last Character to Transmit (LCT) is used for transmitting the last character, then TBE will not be set at the end of the transmission.

#### 8.1.5 CARDS REGISTERS

When working with a card, the following registers may be used for programming some specific parameters:

#### 8.1.5.1 Programmable divider register

The Programmable Divider Register (PDR) is used for counting the cards clock cycles which form the ETU. It is an autoreload 8-bit counter decounting from the programmed value down to 0.

Table 17 Programmable divider register (address 02H; read and write); note 1

| 7   | 6   | 5   | 4   | 3   | 2   | 1   | 0   |
|-----|-----|-----|-----|-----|-----|-----|-----|
| PD7 | PD6 | PD5 | PD4 | PD3 | PD2 | PD1 | PD0 |

#### Note

1. All bits are cleared after reset.

#### 8.1.5.2 UART configuration register 2

Table 18 UART configuration register 2 (address 03H; read and write); note 1

| 27     | 26             | 25 | 24 | 23  | 22       | 21  | 20  |
|--------|----------------|----|----|-----|----------|-----|-----|
| ENINT1 | DISTBE/<br>RBF | _  | _  | SAN | AUTOCONV | CKU | PSC |

#### Note

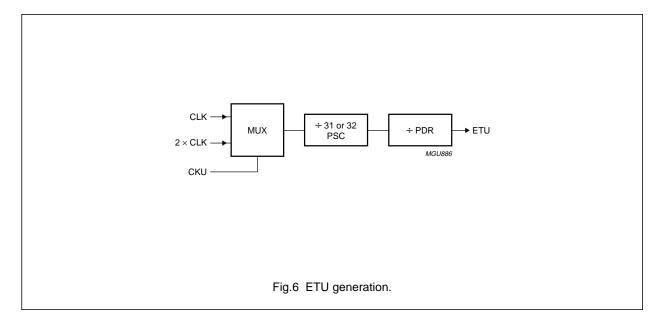
1. All bits are cleared after reset.

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Table 19 Description of the UCR2 bits

| BIT | SYMBOL         | DESCRIPTION   |
|-----|----------------|---|
| 27  | ENINT1         | Enable Interrupt 1: If bit ENINT1 = 1, then a HIGH-to-LOW transition on INT1 will wake-up the microcontroller from power-down mode. When not in power-down mode, bit ENINT1 has no effect.  |
| 26  | DISTBE/<br>RBF | Disable TBE/RBF interrupts: If bit DISTBE/RBF = 1, then reception or transmission of a character will not generate an interrupt. This feature is useful for increasing communication speed with the card; in this case, the copy of TBE/RBF bit within the MSR must be polled and not the original, in order not to loose priority interrupts which can occur in the USR.       |
| 25  | _              | not used  |
| 24  | _              | not used  |
| 23  | SAN            | Synchronous/Asynchronous: Bit SAN is set by software if a synchronous card is expected. Then, the UART is bypassed and only bit 0 in the URR and UTR is connected to the I/O. In this case, the clock is controlled by bit SC in the CCR.   |
| 22  | AUTOCONV       | Auto convention: If bit AUTOCONV = 1, then the convention is set by software with bit CONV in the UART Configuration Register. If it is reset, then the configuration is automatically detected on the first received character while the bit SS (Start Session) is set.  |
| 21  | СКИ            | Clock UART: Bit CKU is used to clock the UART at twice the clock frequency of the card. An ETU will last $31 \times PDR$ clock pulses if CKU = 0 and half if CKU = 1. It should be noted that when CKU = 1 it has no effect if $f_{CLK} = f_{XTAL1}$ . This means, for example, that a baud rate of 76800 is not possible when the card is clocked with the frequency on XTAL1. |
| 20  | PSC            | Prescaler: If bit PSC = 1, then the prescaler value is 32. If PSC = 0, then the prescaler value is 31. One ETU will last a number of cards clock cycles equal to PSC $\times$ PDR. All baud rates specified in "ISO7816" norm are achievable with this configuration.   |



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8.1.5.3 Baud rate selection using F and D; card clock frequency  $f_{CLK} = 3.58$  MHz for PSC = 31 and 4.92 MHz for PSC = 32 (31;12 means prescaler set to 31 and PDR set to 12)

|   |                |                |               |               |               |               | F             |                |                |                |                |               |
|---|----------------|----------------|---------------|---------------|---------------|---------------|---------------|----------------|----------------|----------------|----------------|---------------|
| D | 0              | 1              | 2             | 3             | 4             | 5             | 6             | 9              | 10             | 11             | 12             | 13            |
| 1 | 31;12<br>9600  | 31;12<br>9600  | 31;18<br>6400 | 31;24<br>4800 | 31;36<br>3200 | 31;48<br>2400 | 31;60<br>1920 | 32;16<br>9600  | 32;24<br>6400  | 32;32<br>4800  | 32;48<br>3200  | 32;64<br>2400 |
| 2 | 31;6<br>19200  | 31;6<br>19200  | 31;9<br>12800 | 31;12<br>9600 | 31;18<br>6400 | 31;24<br>4800 | 31;30<br>3840 | 32;8<br>19200  | 32;12<br>12800 | 32;16<br>9600  | 32;24<br>6400  | 32;32<br>4800 |
| 3 | 31;3<br>38400  | 31;3<br>38400  |               | 31;6<br>19200 | 31;9<br>12800 | 31;12<br>9600 | 31;15<br>7680 | 32;4<br>38400  | 32;6<br>25600  | 32;8<br>19200  | 32;12<br>12800 | 32;16<br>9600 |
| 4 |                |                |               | 31;3<br>38400 |               | 31;6<br>19200 |               | 32;2<br>76800  | 32;3<br>51300  | 32;4<br>38400  | 32;6<br>25600  | 32;8<br>19200 |
| 5 |                |                |               |               |               | 31;3<br>38400 |               | 32;1<br>153600 |                | 32;2<br>76800  | 32;3<br>51300  | 32;4<br>38400 |
| 6 |                |                |               |               |               |               |               |                |                | 32;1<br>153600 |                | 32;2<br>76800 |
| 8 | 31;1<br>115200 | 31;1<br>115200 |               | 31;2<br>57600 | 31;3<br>38400 | 31;4<br>28800 | 31;5<br>23040 |                | 32;2<br>76800  |                | 32;4<br>38400  |               |
| 9 |                |                |               |               |               |               | 31;3<br>38400 |                |                |                |                |               |

#### 8.1.5.4 Guard time register

The Guard Time Register (GTR) is used for storing the number of guard ETUs given by the card during ATR. In transmission mode, the UART will wait this number of ETU + 0.5 before transmitting the character stored in UTR. In T = 1 protocol, GTR = FFH means operation at 11.5 ETU. In T = 0 protocol and GTR = FFH means operation at 12.5 ETU.

Table 20 Guard time register (address 05H; read and write); note 1

| 7  | 6     | 5   | 4   | 3   | 2   | 1   | 0   |
|----|-------|-----|-----|-----|-----|-----|-----|
| GT | 7 GT6 | GT5 | GT4 | GT3 | GT2 | GT1 | GT0 |

#### Note

1. All bits are cleared after reset.

#### 8.1.5.5 UART configuration register 1

The UART Configuration Register 1 (UCR1) is used for setting the parameters of the ISO UART.

Table 21 UART configuration register 1 (address 06H; read and write); note 1

| 7 | 6   | 5  | 4    | 3   | 2   | 1  | 0    |
|---|-----|----|------|-----|-----|----|------|
| _ | FIP | FC | PROT | T/R | LCT | SS | CONV |

#### Note

1. All bits are cleared after reset.

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Table 22 Description of the UCR1 bits

| BIT | SYMBOL | DESCRIPTION  |
|-----|--------|--|
| 7   | _      | not used   |
| 6   | FIP    | Force Inverse Parity: If FIP = 1, then the UART will NAK a correct received character and will transmit characters with wrong parity bit.  |
| 5   | FC     | Bit FC is a test bit and must be left at logic 0.  |
| 4   | PROT   | Protocol: Bit PROT = 1 if the protocol type is asynchronous $T = 1$ . If PROT = 0, the protocol is $T = 0$ .   |
| 3   | T/R    | Transmit/Receive: Bit T/R is set by software for transmission mode. A change from 0 to 1 will set bit TBE in the USR. T/R is automatically reset by hardware if LCT has been used before transmitting the last character.  |
| 2   | LCT    | Last Character to Transmit: Bit LCT is set by software before writing the last character to transmit into the UTR. It allows automatic change to reception mode when reset by hardware at the end of a successful transmission (11 + $^{28}$ / <sub>31</sub> or $^{28}$ / <sub>32</sub> ETU in T = 0 and 10 + $^{28}$ / <sub>31</sub> or $^{28}$ / <sub>32</sub> ETU in T = 1). When LCT is being reset, the bit T/R is also reset and the UART is then ready for receiving a character. |
| 1   | SS     | Start Session: Bit SS is set by software before ATR for automatic convention detection and early answer detection. It is automatically reset by hardware at 10.5 ETU after reception of the initial character.   |
| 0   | CONV   | Convention: Bit CONV = 1 if the convention is direct. CONV is either automatically written to by hardware, according to the convention detected during ATR, or by software if bit AUTOCONV is set.   |

### 8.1.5.6 Clock configuration register

The Clock Configuration Register (CCR) defines the clock to the card and the clock to the ISO UART. If bit CKU in the Prescaler Register (UCR2) of the card is set, then the ISO UART is clocked at twice the frequency to the card, this allows higher baud rates to be reached than foreseen in the ISO7816 norm.

Table 23 Clock configuration register (address 01H; read and write); note 1

| 7 | 6 | 5   | 4   | 3  | 2   | 1   | 0   |
|---|---|-----|-----|----|-----|-----|-----|
| _ | _ | SHL | CST | SC | AC2 | AC1 | AC0 |

#### Note

1. All bits are cleared after reset.

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Table 24 Description of the CCR bits

| BIT    | SYMBOL     | DESCRIPTION  |
|--------|------------|--|
| 7      | -          | not used   |
| 6      | _          | not used   |
| 5      | SHL        | Stop HIGH or LOW: If bit CST = 1, then the clock is stopped at LOW level if SHL = 0 and at HIGH level if SHL = 1. In these modes, the bias current in the card drivers is reduced; the current drawn by the card ( $I_{CC}$ ) should be less than 10 mA at all $V_{CC}$ voltages.  |
| 4      | CST        | Clock stop: In case of asynchronous cards, bit CST defines whether the clock to the card is stopped or not. If bit CST is reset, then the clock is determined by bits AC0, AC1 and AC2; see Table 25. All frequency changes are synchronous, thus ensuring that no spike or unwanted pulse widths occurs during changes.   |
| 3      | SC         | Synchronous Clock: In the event of synchronous cards, the clock contact is a copy of the value written in SC. In reception mode, the data from the card is available in bit URO after a read operation of the URR register. In transmission mode, bit UTO is written on the I/O line of the card when UTR register has been written.   |
| 2 to 0 | AC2 to AC0 | When switching from $\frac{1}{n}f_{xtal}$ to $\frac{1}{2}f_{int}$ or vice versa, only bit AC2 must be changed; AC1 and AC0 must remain the same. When switching from $\frac{1}{n}f_{xtal}$ or $\frac{1}{2}f_{int}$ to CLK STOP or vice versa, only bits CST and SHL must be changed.   |
|        |            | When switching from $^{1}/_{n}f_{xtal}$ to $^{1}/_{2}f_{int}$ or vice versa, a maximum delay of 200 $\mu$ s can occur between the command and the effective frequency change on pin CLK. The fastest switch is from $^{1}/_{2}f_{xtal}$ to $^{1}/_{2}f_{int}$ or vice versa, the best duty cycle is from $^{1}/_{8}f_{xtal}$ to $^{1}/_{2}f_{int}$ or vice versa. The status bit CLKSW within the MSR gives the effective switch moment. |

Table 25 CLK value for an asynchronous card

| AC2 | AC1 | AC0 | <b>CLK</b> <sup>(1)</sup>                     |
|-----|-----|-----|---|
| 0   | 0   | 0   | f <sub>xtal</sub>                             |
| 0   | 0   | 1   | ¹∕₂f <sub>xtal</sub>                          |
| 0   | 1   | 0   | ¹∕₄f <sub>xtal</sub>                          |
| 0   | 1   | 1   | <sup>1</sup> / <sub>8</sub> f <sub>xtal</sub> |
| 1   | 0   | 0   | ½f <sub>int</sub>                             |
| 1   | 0   | 1   | ½f <sub>int</sub>                             |
| 1   | 1   | 0   | ½f <sub>int</sub>                             |
| 1   | 1   | 1   | ½f <sub>int</sub>                             |

#### Note

1. If  $f_{CLK} = f_{XTAL}$ , the duty cycle must be ensured by the incoming clock signal on XTAL1.

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#### 8.1.5.7 Power control register

The Power Control Register (PCR) performs two tasks:

- 1. Starts or stops card sessions
- 2. Reads from or writes to auxiliary card contacts C4 and C8.

Table 26 Power control register (address 07H; read and write); note 1

| 7 | 6 | 5  | 4  | 3    | 2     | 1    | 0     |
|---|---|----|----|------|-------|------|-------|
| _ | _ | C8 | C4 | 1.8V | RSTIN | 3/5V | START |

#### Note

1. All bits are cleared after reset.

Table 27 Description of the PCR bits

| BIT | SYMBOL | DESCRIPTION  |
|-----|--------|--|
| 7   | _      | not used   |
| 6   | _      | not used   |
| 5   | C8     | Contact 8: When writing to the PCR bit C8 will output the value of bit C8. When reading from the PCR, bit C8 will store the value on pin C8.   |
| 4   | C4     | Contact 4: When writing to the PCR bit C4 will output the value written of bit C4. When reading from the PCR bit C4 will store the value on pin C4.  |
| 3   | 1.8V   | 1.8 V cards: if bit 1.8V is set, then $V_{CC} = 1.8 \text{ V}$ .   |
| 2   | RSTIN  | Reset bit: When the card is activated, pin RST is the copy of the value written in RSTIN.  |
| 1   | 3/5V   | 3 or 5 V cards: If bit 3/5V is set to logic 1, then $V_{CC}$ is 3 V; If bit 3/5V is set to logic 0, then $V_{CC}$ is 5 V.  |
| 0   | START  | Start: If the microcontroller sets bit START to logic 1, then the selected card is activated; see Section 8.3.3. If the microcontroller resets START to logic 0, then the card is deactivated; see Section 8.3.4. START is automatically reset in the event of emergency deactivation. |
|     |        | For deactivating the card, only bit START should be reset.   |

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8.1.6 REGISTERS SUMMARY

| NAME | ADDR | R/W | 7      | 6              | 5     | 4     | 3     | 2            | 1     | 0       | VALUE AT<br>RESET | VALUE<br>WHEN<br>RIU = 0 |
|------|------|-----|--------|----------------|-------|-------|-------|--------------|-------|---------|-------------------|--------------------------|
| CSR  | 00H  | R/W | -      | -              | -     | -     | RIU   | -            | -     | -       | XXXX0XXX          | XXXX0XXX                 |
| CCR  | 01H  | R/W | -      | -              | SHL   | CST   | SC    | AC2          | AC1   | AC0     | XX000000          | XX000000                 |
| PDR  | 02H  | R/W | PD7    | PD6            | PD5   | PD4   | PD3   | PD2          | PD1   | PD0     | 00000000          | 00000000                 |
| UCR2 | 03H  | R/W | ENINT1 | DISTBE/<br>RBF | -     | -     | SAN   | AUTOCO<br>NV | CKU   | PSC     | 00XX0000          | 00XX0000                 |
| GTR  | 05H  | R/W | GT7    | GT6            | GT5   | GT4   | GT3   | GT2          | GT1   | GT0     | 00000000          | 00000000                 |
| UCR1 | 06H  | R/W | -      | FIP            | FC    | PROT  | T/R   | LCT          | SS    | CONV    | X0000000          | X0000000                 |
| PCR  | 07H  | R/W | -      | -              | C8    | C4    | 1.8 V | RSTIN        | 3/5 V | START   | XX110000          | XX110000                 |
| TOC  | 08H  | R/W | TOC7   | TOC6           | TOC5  | TOC4  | TOC3  | TOC2         | TOC1  | TOC0    | 00000000          | 00000000                 |
| TOR1 | 09H  | W   | TOL7   | TOL6           | TOL5  | TOL4  | TOL3  | TOL2         | TOL1  | TOL0    | 00000000          | 00000000                 |
| TOR2 | 0AH  | W   | TOL15  | TOL14          | TOL13 | TOL12 | TOL11 | TOL10        | TOL9  | TOL8    | 00000000          | 00000000                 |
| TOR3 | 0BH  | W   | TOL23  | TOL22          | TOL21 | TOL20 | TOL19 | TOL18        | TOL17 | TOL16   | 00000000          | 00000000                 |
| MSR  | 0CH  | R   | CLKSW  | FE             | BGT   | -     | _     | PR           | -     | TBE/RBF | 010XXXX0          | 010XXXX0                 |
| FCR  | 0CH  | W   | -      | PEC2           | PEC1  | PEC0  | _     | FL2          | FL1   | FL0     | X000X000          | X000X000                 |
| UTR  | 0DH  | W   | UT7    | UT6            | UT5   | UT4   | UT3   | UT2          | UT1   | UT0     | 00000000          | 00000000                 |
| URR  | 0DH  | R   | UR7    | UR6            | UR5   | UR4   | UR3   | UR2          | UR1   | UR0     | 00000000          | 00000000                 |
| USR  | 0EH  | R   | TO3    | -              | TO1   | EA    | PE    | OVR          | FER   | TBE/RBF | 0X000000          | 00000000                 |
| HSR  | 0FH  | R   | -      | -              | PRTL  | SUPL  | _     | PRL          | _     | PTL     | XX01X0X0          | XX01X0X0                 |

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#### 8.2 SUPPLY

The supply to the chip is delivered by the USB-bus (pins  $V_{DDU}$  and UGND).

#### 8.2.1 POWER SWITCH CONTROL

A power switch control is used in order to limit the inrush current when plugging the reader into the bus. The main decoupling capacitor is connected to the output of this power switch control (pin  $V_{DD}$ ).

#### 8.2.2 3.3 V REGULATOR

The output voltage of the 3.3 V linear regulator is used for:

- Powering-up the microcontroller and the ISO7816 UART
- It is the reference voltage for the signalling pull-up resistor connected to pin D+.

If this voltage is used within the application, the current should not exceed 10 mA.

For stability reasons, a 1  $\mu$ F low ESR decoupling capacitor is needed between the output of the regulator (V<sub>DDD</sub>) and the specific regulator ground (DGND).

For programming the EPROM of the TDA8030; TDA8031, by applying a logic 1 to pin CPROG it will disable the regulator, so that the microcontroller will be powered-up at 5 V.

#### 8.2.3 DC-TO-DC CONVERTER

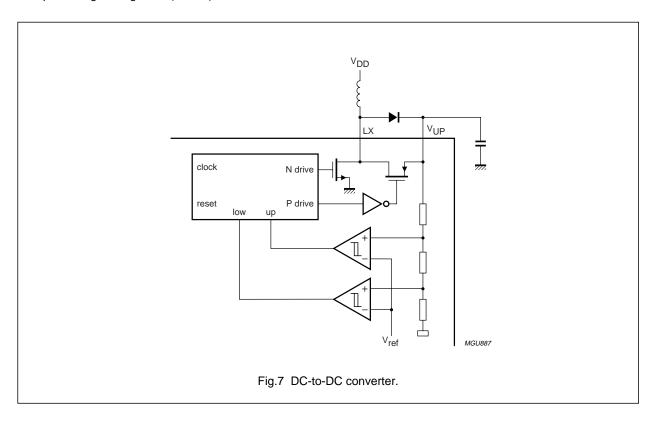
In case of a 5 V card, the card buffers are supplied by an inductive DC-to-DC converter.

In case of a 3 or 1.8 V card, the DC-to-DC converter is transparent and the card buffers are then supplied directly by  $V_{DD}$ .

The external components for the DC-to-DC converter should be an inductance of 6.8  $\mu$ H, a low ESR capacitor of 1  $\mu$ F and a Schottky diode (type BAT54).

The power efficiency is approximately 85% up to  $I_{CC}$  = 55 mA. The current is limited at 100 mA during the start-up phase to avoid spurious supply drop-outs.

The DC-to-DC converter is transparent for a 3 V card.



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#### 8.2.4 SUPPLY SUPERVISOR

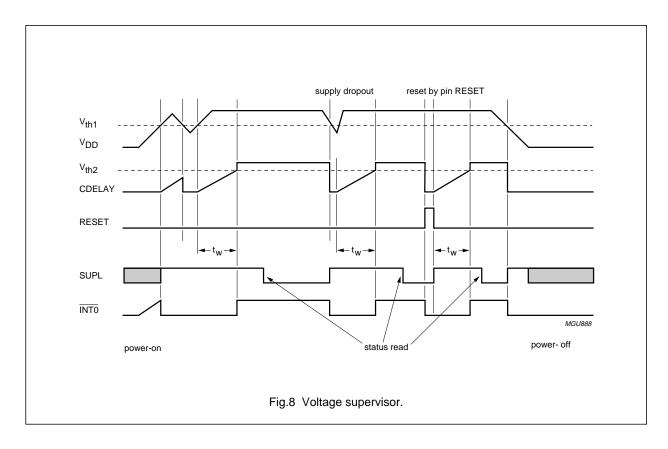
The switched supply voltage ( $V_{DD}$ ) is surveyed by a voltage supervisor, to ensure proper Power-on reset when the reader is plugged into the USB-bus, to maintain all cards contacts inactive during power-on and also to enforce an emergency deactivation sequence in case of  $V_{DD}$  drop-out or when the reader is unplugged from the USB-bus.

The voltage supervisor generates an alarm pulse, whose length is defined by an external capacitor tied to the CDELAY pin, when  $V_{DD}$  is too low to ensure proper operation (1 ms per 2 nF typical).

This pulse is used as a Power-on reset pulse and also to either block any spurious spikes on card contacts during microcontrollers reset, or to force an automatic deactivation of the contacts in the event of supply drop-out; see Sections 8.3.3 and 8.3.4.

After power-on, or after a voltage drop, bit SUPL is set within the Hardware Status Register (HSR) and remains set until HSR is readout outside the alarm pulse. As long as the Power-on reset is active,  $\overline{\text{INT0}}$  is LOW.

The same events occurs when the RESET pin has been set active; the RESET pin should be set HIGH for a minimum of 100  $\mu$ s for a proper reset.



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#### 8.3 ISO7816 SECURITY

#### 8.3.1 Introduction

The correct sequence during activation and deactivation of the cards is ensured through a specific sequencer, clocked by a division ratio of the internal oscillator.

Activation (START bit HIGH in the Power Control Register) is only possible if the card is present (PRES active HIGH) and if the supply voltage is correct (supervisor not active).

The presence of the card is signalled to the microcontroller by the Hardware Status Register (HSR).

Bit PRL in the HSR is set if the card is present. Bit PRL in the HSR is set if bit PRL has toggled.

During a session, the sequencer performs an automatic emergency deactivation on the card in the event of card take off, a short-circuit, a supply drop-out or overheating. When the HSR register is updated and the INTO line goes LOW, the microcontroller will also be updated.

#### 8.3.2 PROTECTIONS AND LIMITATIONS

The TDA8030; TDA8031 features the following protections and limitations:

- 1.  $I_{CC}$  limited to 100 mA, deactivated when this limit is reached
- Current to and from RST is limited to 20 mA, deactivated when this limit is reached
- 3. Deactivation when the temperature of the die exceeds 150  $^{\circ}\text{C}$
- 4. Current to and from the I/O is limited to 10 mA
- Current to and from pin CLK is limited to 70 mA (not in current reduction modes, when clock is stopped)
- ESD protection on all cards contacts + PRES at 6 kV (min.), thus no need of extra components for protection against ESD flash caused by a charged card being introduced in the slot
- Short-circuit between any cards contacts can last any duration without any damage.

#### 8.3.3 ACTIVATION SEQUENCE

When the card is inactive,  $V_{CC}$ , CLK, RST, I/O, C4 and C8 are LOW, with low-impedance with referenced to CGND. The DC-to-DC converter is stopped.

When everything is in normal conditions (no error flag set), the microcontroller will initiate an activation sequence of the card.

After leaving the UART reset mode and then configuring the necessary parameters for the UART, the START bit in the PCR ( $t_0$ ) will be activated. The following sequence then occurs:

- 1. The DC-to-DC converter is started (t<sub>1</sub>)
- V<sub>CC</sub> starts rising from 0 to 5 V or 3 or 1.8 V with a controlled rise time of 0.17 V/μs typically (t<sub>2</sub>)
- 3. I/O, C4 and C8 rise to  $V_{CC}$  (t<sub>3</sub>); integrated 10 k $\Omega$  pull-up resistors connected to  $V_{CC}$
- Clock pulses are sent to the card and RST is enabled (t<sub>4</sub>).

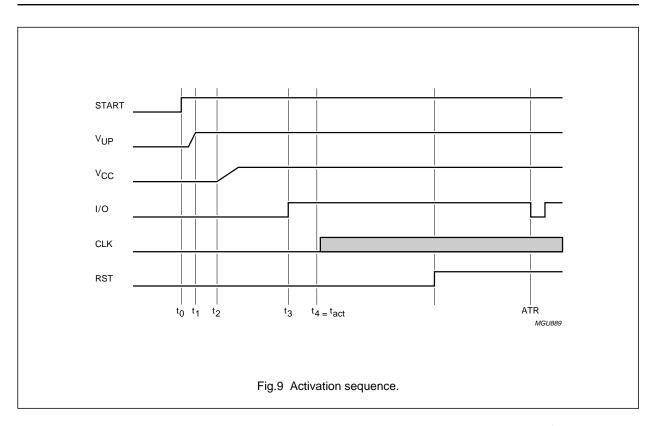
After a number of clock pulses that can be counted with the Time-Out Counter, the bit RSTIN may be set by software and RST will rise to  $V_{\rm CC}$ .

The sequencer is clocked by  $\frac{1}{64}f_{int}$  which leads to a time interval of t = 25  $\mu s$  typical.

Thus  $t_1 = 0$  to  $\frac{3}{64}t$ ,  $t_2 = t_1 + \frac{5}{2}t$ ,  $t_3 = t_1 + \frac{9}{2}t$  and  $t_4 = t_1 + 5t$ .

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#### 8.3.4 DEACTIVATION SEQUENCE

When the session is completed, the microcontroller resets START ( $t_{10}$ ). The circuit then executes an automatic deactivation sequence as follows:

- 1. Card reset (RST falls LOW; t<sub>11</sub>)
- 2. Clock (CLK) is stopped LOW (t<sub>12</sub>)
- 3. I/O, C4 and C8 fall to 0 V (t<sub>13</sub>)
- 4.  $V_{CC}$  falls to 0 V with typical 0.17 V/ $\mu$ s slew rate (t<sub>14</sub>)
- 5. The DC-to-DC converter is stopped and CLK, RST,  $V_{CC}$ , I/O, C4 and C8 become low-impedance to CGND ( $t_{15}$ ).

#### Thus:

$$t_{11} = t_{10} + \frac{1}{64}t$$

$$t_{12} = t_{11} + \frac{1}{2}t$$

$$t_{13} = t_{11} + t$$

$$t_{14} = t_{11} + \frac{3}{2}t$$

$$t_{15} = t_{11} + \frac{7}{2}t$$

 $t_{de}$  = time that  $V_{CC}$  needs to decrease to less than 0.3 V.

Automatic emergency deactivation is performed in the following cases:

- 1. Withdrawal of the card (PRES LOW)
- 2. Overcurrent detection on V<sub>CC</sub> (bit PRTL set)
- 3. Overcurrent detection on RST (bit PRTL set)
- 4. Overheating (bit PTL set)
- 5. Supply too low (bit SUPL set)
- 6. RESET pin active HIGH.

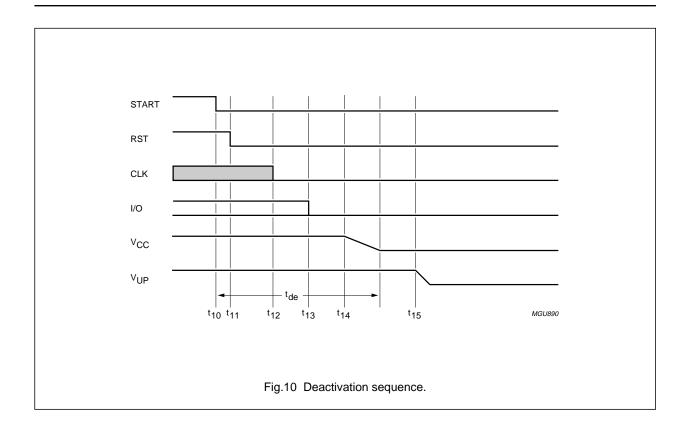
In all of these cases, the deactivation sequence as described above occurs.

If the reason for the deactivation is a card take-off, an overcurrent or overheating, then  $\overline{\text{INT0}}$  will be LOW and the corresponding bit in the Hardware Status Register will be set. The START bit is automatically reset.

If the reason is a supply drop-out, then the deactivation sequence occurs and a complete reset of the chip is performed. When the supply recovers, then the SUPL bit will be set in the HSR.

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#### 8.4 MICROCONTROLLER

The embedded microcontroller is an 80C51RB+ with an internal 16 kbyte EPROM (80C51FB with 16 kbyte ROM for the TDA8031), 256 RAM and 512 AUXRAM. It has the same instruction set as the 80C51.

The embedded microcontroller is clocked by the frequency present on pin XTAL1.

The embedded microcontroller may be reset by an active HIGH signal on pin RESET, but it is also reset by the Power-on reset signal generated by the voltage supervisor.

The external interrupt  $\overline{\text{INT0}}$  is used by the ISO UART, by the analog drivers and by the ETU counters. It must be left open-circuit in the application.

The external interrupt  $\overline{\text{INT1}}$  is used by the USB interface. It must be left open-circuit in the application.

A general description, together with the added features, is described below.

The added features to the 80C51 microcontroller are similar to the 8XC51FB/RB+ microcontrollers, except for the wake-up from power-down mode, which is enabled by a falling edge on pin  $\overline{\text{INT0}}$  (card reader event) or on pin  $\overline{\text{INT1}}$  due to the addition of an extra delay counter and enable configuration bits within the UCR2 register; see Section 8.4.1. For further information please refer to the published specification of the 8xC51RB + /FB in "Data Handbook IC20; 80C51-Based 8-bit Microcontrollers".

The 80C51 microcontroller has four 8-bit I/O ports, three 16-bit timer/event counters, a multi-source, 4-level priority nested interrupt structure, an enhanced UART and on-chip oscillator and timing circuits. For systems that require extra memory capability up to 64 kbytes, it can be expanded by using standard TTL compatible memories and logic.

- 1. 80C51 Central Processing Unit (CPU)
- 2. Full static operation
- 3. Security bits: ROM 2 bits
- 4. Encryption array of 64 bits
- 5. 4-level priority structure
- 6. 6 interrupt sources
- Full duplex enhanced UART with framing error detection and automatic address recognition
- 8. Power control modes (the clock can be stopped and resumed in IDLE mode and power-down mode)
- 9. Wake-up from power-down by a falling edge on pins INTO and INT1; with an embedded delay counter
- 10. Programmable clock output
- 11. Second DPTR register
- 12. Asynchronous port reset
- 13. Low EMI (inhibit ALE).

Table 28 gives a list of main features to get a better understanding of the differences between a standard 80C51, an 8XC51RB+ and the embedded microcontroller in the TDA8030; TDA8031.

Table 28 Principal blocks in the 80C51, 8XC51RB+ and the TDA8030; TDA8031

| FEATURE                    | 80C51     | 8XC51RB+                                  | TDA8030; TDA8031 |  |  |
|----------------------------|-----------|---|------------------|--|--|
| ROM/EPROM                  | 4 kbytes  | 16 kbytes                                 | 16 kbytes        |  |  |
| RAM                        | 128 bytes | 256 bytes                                 | 256 bytes        |  |  |
| ERAM (MOVX)                | no        | 256 bytes                                 | 512 bytes        |  |  |
| PCA                        | no        | yes                                       | no               |  |  |
| WDT                        | no        | yes                                       | no               |  |  |
| T0                         | yes       | yes                                       | yes              |  |  |
| T1                         | yes       | yes                                       | yes              |  |  |
| T2                         | no        | yes                                       | yes              |  |  |
|                            |           | lowest interrupt priority vector at 002BH |                  |  |  |
| 4 level priority interrupt | no        | yes                                       | yes              |  |  |
| enhanced UART              | no        | yes                                       | yes              |  |  |
| delay counter              | no        | no  | yes              |  |  |

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#### 8.4.1 Low power modes

Stop Clock Mode: The static design enables the clock speed to be reduced down to 0 MHz (stopped). When the oscillator is stopped, the RAM and Special Function Registers (SFRs) retain their values. This mode allows step-by-step utilization and permits reduced system power consumption by lowering the clock frequency down to any value. The power-down mode is suggested for the lowest power consumption.

IDLE Mode: In the Idle mode, the CPU puts itself to sleep while all of the on-chip peripherals stay active. The instruction to invoke the Idle mode is the last instruction executed in the normal operating mode before the Idle mode is activated. The CPU contents, the on-chip RAM and all of the special function registers remain intact during this mode. The Idle mode can be terminated either by any enabled interrupt (at which time the process is picked up at the interrupt service routine and continued), or by a hardware reset which starts the processor in the same manner as a Power-on reset.

Power-down Mode: To save even more power, a power-down mode can be invoked by software. In this mode, the oscillator is stopped and the instruction that invoked the power-down is the last instruction executed.

Either a hardware reset or external interrupt can be used to exit from the power-down mode. Applying a reset redefines all of the SFRs but does not change the on-chip RAM. An external interrupt allows both the SFRs and the on-chip RAM to retain their values.

The bits in the Interface Engine (IE) must be enabled with INT0 and INT1. Within the INT0 interrupt service routine, the microcontroller has to read out the Hardware Status Register (HSR at 0FH) and/or the UART Status register (USR at 0EH) by means of MOVX instructions in order to establish the exact interrupt reason and to reset the interrupt source.

For enabling a wake-up by  $\overline{\text{INT1}}$ , the bit ENINT1 within UCR2 must be set.

An integrated delay counter maintains  $\overline{\text{INT0}}$  and  $\overline{\text{INT1}}$  LOW long enough to allow the oscillator to restart properly. A falling edge on pins  $\overline{\text{INT0}}$  and  $\overline{\text{INT1}}$  is enough to awaken the whole circuit.

Once the interrupt is serviced, the next instruction to be executed after RETI will be the one following the instruction that put the device into power-down.

#### 8.5 USB INTERFACE

#### 8.5.1 END-POINTS

The TDA8030; TDA8031 has 4 logic end-points which are listed in Table 29.

Each physical end-point, except for the control ones, can be enabled or disabled. All enabled end-points generate interrupts to the microcontroller via INT1 when the end-point needs to be serviced.

The implementation of the function makes use of an SRAM for buffering the data.

Logic end-points can be accessed by the microcontroller interface.

Table 29 Mapping of logic to physical end-point numbers for used end-points

| END-POINT NAME                               | LOGIC     | BUFFER SIZE | PHYSICAL END-POINT |    |  |
|--|-----------|-------------|--------------------|----|--|
| END-FOINT NAME                               | END-POINT | BUFFER SIZE | OUT                | IN |  |
| Control end-point                            | 0         | 16          | 0                  | 1  |  |
| Generic end-point (may be used as bulk       | 1         | 32          | 2                  | 3  |  |
| Generic end-point (may be used as interrupt) | 2         | 8           | -                  | 4  |  |
| Generic end-point                            | 3         | 8           | _                  | 5  |  |

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#### 8.5.2 Phase-locked loop

A 12 to 48 MHz clock multiplier PLL is integrated on-chip. No external components are needed for the operation of the PLL.

#### 8.5.3 BIT CLOCK RECOVERY

The bit clock recovery circuit recovers the clock from the incoming USB data stream using 4× oversampling principle. It is able to track jitter and frequency drift as specified by the USB specification.

#### 8.5.4 INTERFACE SIGNALS WITH THE MICROCONTROLLER

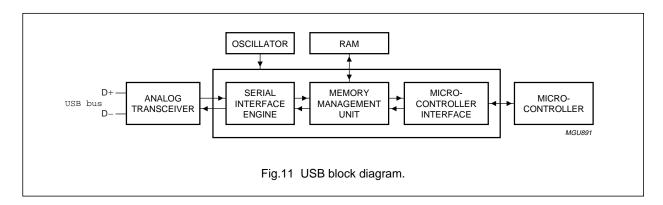
**Table 30** The following I/O ports of the 83C51 are used for controlling the USB bus:

| PORT | FUNCTION            | DESCRIPTION   |
|------|---------------------|---|
| P10  | USB_INT_MASK        | should be set to logic 1 before entering power-down mode during suspend and reset to logic 0 when leaving power-down mode                   |
| P11  | USB_SOFTCONNECT_INT | when set to logic 1, the internal 1.5 k $\Omega$ resistor is connected to pin D+  |
| P12  | USB_MC_READY        | the device is ready to accept a new transaction   |
| P13  | USB_CLK_EN_N        | when LOW, this signal indicates that the bus is no longer suspended   |
| P14  | USB_RESET_N         | a LOW-level will reset the USB interface  |
| P15  | USB_SOFTCONNECT_EXT | when set to logic 1, $V_{DDD}$ is applied on the optional external 1.5 k $\Omega$ resistor which has been placed between pins D+ and DELATT |
| P33  | USB_INT_N           | interrupt to the microcontroller  |
| P34  | USB_SUSPEND         | the device is in suspended state (TDA8030 only)   |
| P35  | USB_WAKEUP_N        | remote wake-up (TDA8030 only)   |
| P25  | USB_MP_C            | if set to logic 1, the data to the bus is a command; if set to logic 0 it is data   |
| P26  | USB_MP_SEL          | if set to logic 1, the USB interface is selected  |

#### 8.5.5 BLOCK DIAGRAM

The digital interface consists of 3 major blocks:

- The Philips Serial Interface Engine (SIE) handles the USB protocol (i.e. synchronization pattern, recognition, parallel/serial conversion, bit stuffing/de-stuffing, CRC checking/generating, PID verification/generation, address recognition and handshake evaluation/generation)
- A Memory Management Unit (MMU), controlling the buffering of data to and from the bus
- · An interface to the embedded 83C51 microcontroller.



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### 8.5.6 USB REGISTERS

A first MOVX@DPTR instruction enables the module to be selected (via DPH) and send the command. A second one communicates the data (read or write).

8.5.7 INSTRUCTION SET

8.5.7.1 Overview

Table 31 summarizes all commands that can be used by the embedded microcontroller.

Table 31 Instruction set

| COMMAND NAME                  | RECIPIENT          | CODING | FUNCTION          | DATA PHASE             |
|-------------------------------|--------------------|--------|-------------------|------------------------|
| Device commands; s            | ee Table 32        | •      |                   |                        |
| Set address                   | device             | 0XD0H  | set address       | write 1 byte           |
| Set end-points enable         | device             | 0XD8H  | set EP enable     | write 1 byte           |
| Set mode                      | device             | 0XF3H  | set mode          | write 1 byte           |
| Read interrupt register       | device             | 0XF4H  |                   | read 1 byte            |
| Read current frame number     | device             | 0XF5H  |                   | read 1 or 2 bytes      |
| Read chip ID                  | device             | 0XFDH  |                   | read 2 bytes           |
| Get device status             | device             | 0XFEH  |                   | read 1 byte            |
| Set device status             | device             | 0XFEH  |                   | write 1 byte           |
| Debug command: get error code | device             | 0XFFH  |                   | read 1 byte            |
| End-point commands            | s; see Table 41    |        |                   | •                      |
| Select end-point              | control output     | 0X00H  | select EP0 output | read 1 byte (optional) |
|                               | control input      | 0X01H  | select EP0 input  | read 1 byte (optional) |
|                               | end-point 1 output | 0X02H  |                   | read 1 byte (optional) |
|                               | end-point 1 input  | 0X03H  |                   | read 1 byte (optional) |
|                               | end-point 2 input  | 0X04H  |                   | read 1 byte (optional) |
|                               | end-point 3 input  | 0X05H  |                   | read 1 byte (optional) |
| Select end-point/clear        | control output     | 0X40H  |                   | read 1 byte            |
| interrupt                     | control input      | 0X41H  |                   | read 1 byte            |
|                               | end-point 1 output | 0X42H  |                   | read 1 byte            |
|                               | end-point 1 input  | 0X43H  |                   | read 1 byte            |
|                               | end-point 2 input  | 0X44H  |                   | read 1 byte            |
|                               | end-point 3 input  | 0X45H  |                   | read 1 byte            |
| Set end-point status          | control output     | 0X40H  |                   | write 1 byte           |
|                               | control input      | 0X41H  |                   | write 1 byte           |
|                               | end-point 1 output | 0X42H  |                   | write 1 byte           |
|                               | end-point 1 input  | 0X43H  |                   | write 1 byte           |
|                               | end-point 2 input  | 0X44H  |                   | write 1 byte           |
|                               | end-point 3 input  | 0X45H  |                   | write 1 byte           |
| Read buffer                   | selected end-point | 0XF0H  |                   | read n + 2 bytes       |
| Write buffer                  | selected end-point | 0XF0H  |                   | write n + 2 bytes      |
| Clear buffer                  | selected end-point | 0XF2H  |                   | read 1 byte (optional) |
| Validate buffer               | selected end-point | 0XFAH  |                   | none                   |

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Table 32 Device commands

| COMMAND                             | DESCRIPTION   |
|-------------------------------------|---|
| Set address                         | The set address command is used to set the USB assigned address and to enable the function. In the event that the status phase of the set address transaction is not successful, the device address will not be updated. The power-on value is given in Table 33.   |
| Set end-points enable               | A value of 1 written to the register indicates that the non-control end-points are enabled. The power-on value is given in Table 34.  |
| Set Mode                            | The default value is logic 0; if logic 1 is written in this register, then NAKing is reported and will generate an interrupt. When set to logic 0, only successful transactions are reported.   |
| Read interrupt register             | This command indicates the origin of an interrupt. The end-point interrupt bits are cleared by the Select end-point/Clear Interrupt command. The power-on value is given in Table 35.   |
| Read Current<br>Frame Number        | The Read Current Frame Number returns the frame number of the last received Start Of Frame (SOF). The frame number is eleven bits wide. The frame number is returned LSB first, so, if the user is only interested in the lower 8 bits of the frame number, only the first byte needs to be read; see Table 36. |
|                                     | The frame number returned by this commend can be invalid in the event of one of the following conditions:   |
|                                     | If no SOF was received by the device at the beginning of a frame, the frame number returned is that of the last successfully received SOF   |
|                                     | • If the SOF frame number contained a CRC error, the frame number received will be the corrupted frame number as received by the device.  |
| Read chip ID                        | The chip Identification is 16 bits wide. The command divides the ID into bytes and returns the least significant byte first: For the TDA8030; TDA8031, the ID is fixed at 2B00H.  |
| Get Device<br>Status                | The Get Device Status command returns the Device Status Register; refer to the Set Device Status command  |
| Set Device                          | The Set Device Status command sets bits in the Device Status Register.  |
| Status                              | In Table 37, the Type column indicates if the bit can be written and if the bit is cleared after reading the register. The Interrupt column indicates if the bit generates an interrupt when it is set.   |
| Debug<br>command: Get<br>Error Code | The Get Error Code command returns the error code of the last generated error; this command is for debugging purpose. The 4 least significant bits form the error code. Bit 4 (Error Occurred) can be cleared by each new transfer. The power-on value is given in Table 39.                                    |
|                                     | This command is only useful during debugging.   |
|                                     | Table 40 gives an overview of the Error Codes.  |

Table 33 Power-on value for Set address

| FUNCTION                      | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------------------------|---|---|---|---|---|---|---|---|
| Device address <sup>(1)</sup> | _ | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Enable <sup>(2)</sup>         | 0 | - | _ | - | _ | _ | _ | _ |

### **Notes**

- 1. The value written becomes the address.
- 2. A logic 1 enables the function.

After a bus reset, the address is reset to 000 0000. The enable bit is set. The device will respond on packets for function address 000 0000, end-point 0 (default end-point).

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Table 34 Power-on value for Set end-points enable

| FUNCTION              | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-----------------------|---|---|---|---|---|---|---|---|
| Enable all end-points | _ | _ | _ | _ | _ | _ | _ | 0 |
| Reserved              | _ | _ | _ | _ | _ | _ | _ | _ |

Table 35 Power-on value for Read interrupt register

| FUNCTION                                | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---|---|---|---|---|---|---|---|---|
| Physical EP0 (control output end-point) | _ | - | - | _ | - | - | - | 0 |
| Physical EP1 (control input end-point)  | _ | - | - | _ | - | - | 0 | - |
| Physical EP2 (generic output end-point) | _ | - | - | _ | - | 0 | - | - |
| Physical EP3 (generic input end-point)  | _ | - | - | _ | 0 | - | - | - |
| Physical EP4 (generic input end-point)  | _ | - | - | 0 | - | _ | - | - |
| Physical EP5 (generic input end-point)  | _ | - | 0 | _ | - | _ | - | - |
| Reserved                                | _ | 0 | _ | _ | - | - | - | - |
| Device event <sup>(1)</sup>             | 0 | - | _ | _ | - | - | - | - |

### Note

Table 36 Read current frame number

| BYTE   | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|--------|---|---|---|---|---|---|---|---|
| Byte 0 | F | F | F | F | F | F | F | F |
| Byte 1 | 0 | 0 | 0 | 0 | 0 | F | F | F |

Table 37 Set device status command functions

| FUNCTION       | TYPE                          | INTERRUPT | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|----------------|-------------------------------|-----------|---|---|---|---|---|---|---|---|
| Reserved       | _                             | _         | - | - | - | - | - | - | 0 | 0 |
| Suspend        | read/write                    | no        | - | - | - | - | - | 0 | _ | _ |
| Suspend change | read only;<br>cleared on read | yes       | - | _ | _ | _ | 0 | _ | _ | _ |
| Bus reset      | read only;<br>cleared on read | yes       | - | _ | - | 0 | - | _ | _ | _ |
| Reserved       | _                             | _         | _ | _ | _ | _ | _ | _ | _ | _ |

<sup>1.</sup> The Device event bit is cleared by issuing the Get Device Status command.

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Table 38 Set device status command function bits

| FUNCTION       | DESCRIPTION  |
|----------------|--|
| Suspend        | The Suspend bit represents the current Suspend state. It is logic 1 when the device has not seen any activity on its upstream port for more than 3 ms. It is reset to logic 0 on any activity.   |
|                | When the device is suspended, (Suspend bit = 1) and the microcontroller writes logic 0 into it, the device will generate a remote wake-up. When the device is not suspended, writing a logic 0 has no effect. Writing a logic 1 in this register has no an effect. |
| Suspend Change | The Suspend Change bit is set to logic 1 when the Suspend bit toggles. The Suspend bit can toggle because:   |
|                | The device goes into the suspended state   |
|                | The device receives resume signalling on its upstream port   |
|                | The Suspend Change bit is reset after the register has been read.  |
| Bus reset      | The Bus reset bit is set when the device receives a bus reset. It is cleared when read. On a bus reset, the device will automatically go to the default state (unconfigured and responding to address 0).  |

Table 39 Power-on value for Get Error Code

| FUNCTION       | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|----------------|---|---|---|---|---|---|---|---|
| Error code     | _ | _ | _ | _ | 0 | 0 | 0 | 0 |
| Error occurred | - | - | - | 0 | _ | _ | - | _ |
| Reserved       | _ | _ | _ | _ | _ | _ | _ | _ |

Table 40 Error codes

| ERROR CODE[3:0] | DESCRIPTION                                |
|-----------------|--|
| 0000            | no error                                   |
| 0001            | PID encoding error                         |
| 0010            | unknown PID                                |
| 0011            | unexpected packet                          |
| 0100            | error in token CRC                         |
| 0101            | error in data CRC                          |
| 0110            | time-out error                             |
| 0111            | babble                                     |
| 1000            | error in end of packet                     |
| 1001            | sent NAK                                   |
| 1010            | sent Stall                                 |
| 1011            | buffer overrun error                       |
| 1100            | reserved                                   |
| 1101            | bitstuff error                             |
| 1110            | error in sync                              |
| 1111            | wrong toggle bit in data PID; ignored data |

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Table 41 End-point commands

| COMMAND                              | DESCRIPTION  |
|--------------------------------------|--|
| Select end-point                     | The select end-point command initializes an internal pointer to the start of the selected buffer. Optionally, this command can be followed by a data read, which returns some additional information on the packet in the buffer. The command code of the select end-point is equal to the physical end-point number. The power-on value is given in Tables 42 and 43. |
| Select End-point/<br>Clear Interrupt | These commands are identical to Select End-point commands, but with the following differences:   |
|                                      | They clear the associated interrupt  |
|                                      | In the event of a control output end-point; they clear the set-up and overwritten bits   |
|                                      | The read one byte is mandatory.  |
| Set end-point status                 | The Set end-point status command sets status bits 7 to 5 and 0 of the end-point. The command code is equal to the sum of 40H and the physical end-point number. Not all bits can be set for all types of end-points. The power-on value is given in Tables 44 and 45.  |
| Read buffer                          | The Read buffer command is followed by a number of data reads, which return the contents of the selected end-point data buffer. After each read, the internal buffer pointer is incremented.   |
|                                      | The buffer pointer is not reset to the beginning of the buffer by the Read buffer command. This means that reading a buffer can be interrupted by any other command (except for the Select end-point).   |
|                                      | The data buffer organization is given in Table 46.   |
| Write buffer                         | The Write buffer command is followed by a number of data writes, which load the data buffer of the selected end-point. After each write, the internal buffer pointer is incremented  |
|                                      | The buffer pointer is not reset to the beginning of the buffer by the Write buffer command. This means that writing to a buffer can be interrupted by any other command (except for the Select end-point and Select end-point/Clear Interrupt).  |
|                                      | The data buffer organization is given in Table 47.   |
| Clear buffer                         | When a packet sent by the host has been received successfully, an internal end-point buffer full flag is set. All subsequent packets will be refused by returning a NAK. When the microcontroller has read the data, it should free the buffer by the Clear buffer command. When the buffer is cleared, new packets will be accepted.                                  |
|                                      | When bit 0 of the optional data byte is set to logic 1, the previously received packet was overwritten by a set-up packet.   |
|                                      | A buffer cannot be cleared when its Packet overwritten bit is set. The power-on value is given in Table 48.  |
| Validate buffer                      | When the microcontroller has written data into an input buffer, it should set the buffer full flag by the Validate buffer command. This indicates that the data in the buffer is valid and can be sent to the host when the next input token is received.  |
|                                      | A control input buffer cannot be validated when the Packet overwritten bit of its corresponding output buffer is set.  |

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Table 42 Power-on value for Select end-point

| FUNCTION           | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|--------------------|---|---|---|---|---|---|---|---|
| Full or empty      | - | _ | - | - | - | - | - | 0 |
| Stall              | - | _ | _ | - | _ | - | 0 | _ |
| Set-up             | - | _ | - | - | - | 0 | - | - |
| Packet overwritten | - | _ | _ | _ | 0 | - | - | _ |
| Sent NAK           | - | _ | _ | 0 | _ | - | - | _ |
| Reserved           | - | - | _ | - | _ | - | - | _ |

Table 43 Description of the Power-on value for Select end-point bits

| FUNCTION           | DESCRIPTION  |
|--------------------|--|
| Full or empty      | If set to logic 1, the buffer of the selected end-point is full.   |
|                    | In the event of an output end-point, this bit is cleared by executing the Clear Buffer command, if the buffer was not overwritten.   |
|                    | In the event of an input end-point, this bit is set by the Validate Buffer command.  |
| Stall              | If set to logic 1, the selected end-point is stalled.  |
| Set-up             | If set to logic 1, the last received packet for the selected end-point was a set-up packet. The value of this bit is updated after each successfully received packet (i.e. an ACKED package on that particular end-point). |
| Packet overwritten | If set to logic 1, the previously received packet was overwritten by a set-up packet. The value of this bit is cleared by the Select End-point command.  |
| Sent NAK           | If set to logic 1, the device has sent a NAK. If the host sends an output packet to a filled output buffer, the device returns a NAK. If the host sends an input token to an empty input buffer, the device returns a NAK. |
|                    | This bit is set when a NAK is sent and the Interrupt On Nak feature is enabled.  |
|                    | This bit is reset after the device has sent an ACK after an output packet or when the device has seen an ACK after sending an input packet. It is only defined for the 2 physical control end-points.                      |

Table 44 Power-on value for Set end-point status; notes 1 and 2

| FUNCTION           | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | CTRL EP | GEN IN/OUT | GEN IN |
|--------------------|---|---|---|---|---|---|---|---|---------|------------|--------|
| Stall              | _ | _ | - | _ | _ | _ | _ | 0 | def     | def        | def    |
| Disable            | _ | _ | 0 | _ | _ | _ | _ | - | Х       | def        | def    |
| Rate feedback mode | - | 0 | - | - | - | - | - | _ | Х       | def        | def    |
| Interrupt unmasked | 0 | - | _ | - | - | - | - | _ | Х       | Х          | Х      |
| Conditional stall  | 0 | _ | - | _ | _ | - | _ | _ | def     | Х          | Х      |

### Notes

- 1. X = dont care.
- 2. def means that the bit can be set if the end-point is of the specified type.

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Table 45 Description of the Power-on value for Set end-point status bits

| FUNCTION           | DESCRIPTION  |
|--------------------|--|
| Stall              | If set to logic 1, the end-point is stalled.   |
| Disable            | If set to logic 1, the end-point is disabled. After a bus reset; each end-point is enabled, i.e. this bit is set to logic 0.   |
| Rate feedback mode | If set to logic 0, the interrupt end-point is in toggle mode. If set to logic 1, the interrupt end-point is in rate feedback mode.   |
| Interrupt unmasked | If set to logic 1, an event on the end-point causes an interrupt to the microcontroller.   |
| Conditional stall  | If set to logic 1, both end-points zero are stalled; unless the set-up packet bit is set.  |
|                    | A stalled control end-point is automatically unstalled when it receives a SET-UP token, regardless of the content of the packet. If the end-point stays in the stalled state, the microcontroller should re-install it.  |
|                    | When a stalled end-point is unstalled (either by the Set end-point status command or by receiving a Set-up token) it is also re-initialized. This flushes the buffer: in case of an output buffer, it waits for a DATA 0 PID; in case of an input buffer, it writes a DATA 0 PID. Even when unstalled, setting the stalled bit to logic 0 initializes the end-point. |
|                    | When an end-point is stalled by the Set end-point status command, it is also re-initialized.   |

Table 46 Data buffer organization (read)

| BYTE       | <b>7</b> <sup>(1)</sup> | <b>6</b> <sup>(2)</sup>        | 5 | 4      | 3      | 2 | 1 | 0 |
|------------|-------------------------|--------------------------------|---|--------|--------|---|---|---|
| Byte 0     | 0/1                     | 0/1                            | - | -      | -      | - | - | 0 |
| Byte 1     | -                       | number of data bytes in buffer |   |        |        |   |   |   |
| Byte 2     |                         |                                |   | data l | byte 0 |   |   |   |
|            |                         |                                |   |        |        |   |   |   |
| Byte n + 1 | data byte n – 1         |                                |   |        |        |   |   |   |

### **Notes**

- 1. Bit 7 of Byte 0 indicates whether the packet in the buffer was received successfully over the USB-bus. When this bit is set to logic 1, the packet was received successfully.
- 2. Bit 6 of Byte 0 indicates whether the packet in the buffer is a set-up packet.

Table 47 Data buffer organization (write)

| BYTE       | 7 | 6                              | 5 | 4      | 3      | 2 | 1 | 0 |
|------------|---|--------------------------------|---|--------|--------|---|---|---|
| Byte 0     | - | -                              | - | -      | -      | - | - | 0 |
| Byte 1     | - | number of data bytes in buffer |   |        |        |   |   |   |
| Byte 2     |   |                                |   | data l | byte 0 |   |   |   |
|            |   |                                |   |        |        |   |   |   |
| Byte n + 1 |   | data byte n – 1                |   |        |        |   |   |   |

### Table 48 Power-on value for Clear buffer

| FUNCTION           | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|--------------------|---|---|---|---|---|---|---|---|
| Packet overwritten | _ | _ | _ | _ | _ | _ | _ | 0 |
| Reserved           | _ | _ | _ | _ | _ | _ | _ | - |

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#### 8.5.8 ANALOG INTERFACE

The transceiver interfaces directly to the USB cables through termination resistors. They are able to transmit and receive serial data at full speed (12 Mbits/s).

A 1.5 k $\Omega$  pull-up resistor is integrated between pins D+ and V<sub>DDD</sub> and is connected by software by the microcontroller; in case a  $\pm 5\%$  resistor is preferred, it can be externally connected between pins DELATT and D+ (DELATT is also controlled by software and is floating when OFF, or connected to V<sub>DDD</sub> when ON).

### 8.5.9 SUSPEND MODE

When the USB interface enters Suspend mode, the software should set the microcontroller in power-down mode in order to respect the suspend current condition. The following sequence should be executed:

- 1. When the device enters the Suspend mode, it generates an interrupt on pin INT1
- 2. The software should set USB\_INT\_MASK to logic 1
- Then it should wait until CLK\_EN\_N is HIGH before entering power-down mode.

When the device detects an activity on the bus, it resets CLK\_EN\_N to logic 0 and generates an interrupt on pin INT1. When leaving the Suspend mode, the following sequence should be executed:

- 1. The software should read the DEVICE\_STATUS to enable the interrupt to be cleared
- 2. Reset USB\_INT\_MASK to logic 0.

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### 9 LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

| SYMBOL           | PARAMETER   | CONDITIONS   | MIN.       | MAX. | UNIT |
|------------------|---|--|------------|------|------|
| V <sub>DDU</sub> | bus supply voltage                                    |  | -0.5       | +6.5 | V    |
| V <sub>n</sub>   | input voltage on all pins                             |  | -0.5       | +6.5 | V    |
| P <sub>tot</sub> | total power dissipation                               |  | _          | tbf  | mW   |
| T <sub>stg</sub> | IC storage temperature                                |  | -55        | +150 | °C   |
| Tj               | junction temperature                                  |  | _          | 125  | °C   |
| V <sub>esd</sub> | electrostatic discharge voltage                       | TDA8030; HBM JEDEC   |            |      |      |
|                  | pins I/O, V <sub>CC</sub> , RST, C4, C8, CLK and PRES |  | <b>-</b> 5 | +5   | kV   |
|                  | all other pins  |  | <b>-1</b>  | +1   | kV   |
|                  |   | MM JEDEC   | -50        | +50  | V    |
|                  |   | MM JEDEC   | -100       | +100 | V    |
| V <sub>esd</sub> | electrostatic discharge voltage                       |  |            |      |      |
|                  | pins I/O, V <sub>CC</sub> , RST, C4, C8, CLK and PRES | TDA8031; HBM JEDEC   | -6         | +6   | kV   |
|                  | all other pins  |  | -1.5       | +1.5 | kV   |
| I <sub>lu</sub>  | latch-up free current on all pins                     | JEDEC; maximum<br>voltage is 1.5/–0.5 supply<br>voltage of the block | -100       | +100 | mA   |

### 10 THERMAL CHARACTERISTICS

| SYMBOL               | PARAMETER                                   | CONDITIONS  | VALUE | UNIT |
|----------------------|---|-------------|-------|------|
| R <sub>th(j-a)</sub> | thermal resistance from junction to ambient | in free air | 63    | K/W  |

## USB smart card reader (OTP or ROM)

TDA8030; TDA8031

### 11 CHARACTERISTICS

 $V_{DDU}$  = 5 V;  $T_{amb}$  = 25 °C; unless otherwise specified.

| SYMBOL                  | PARAMETER  | CONDITIONS   | MIN.                | TYP. | MAX.                   | UNIT |
|-------------------------|--|--|---------------------|------|------------------------|------|
| Supplies                | •  |  | 1                   | '    | <b>'</b>               |      |
| V <sub>DDU</sub>        | supply voltage for the bus                             |  | 4.2                 | _    | 5.5                    | V    |
| $V_{DD}$                | supply voltage after inrush current suppression switch |  | 4.2                 | -    | 5.5                    | V    |
| I <sub>DDU</sub>        | supply current for the bus                             | 5 V card; $I_{CC}$ = 40 mA;<br>$f_{clk}$ = 6 MHz             | _                   | -    | 100                    | mA   |
| I <sub>sus</sub>        | suspend current  | card inactive;<br>microcontroller in<br>power-down mode      | -                   | -    | 500                    | μА   |
| V <sub>th(VDD)</sub>    | threshold voltage on V <sub>DD</sub>                   | falling  | 3.6                 | _    | 3.8                    | V    |
| V <sub>hys</sub>        | hysteresis voltage on V <sub>th(VDD)</sub>             |  | 150                 | -    | 350                    | mV   |
| $V_{th(CDELAY)}$        | threshold voltage on pin<br>CDELAY                     |  | _                   | 1.25 | _                      | V    |
| V <sub>CDELAY</sub>     | voltage on pin CDELAY                                  |  | _                   | _    | V <sub>DD</sub> + 0.3  | V    |
| I <sub>o(CDELAY)</sub>  | output current on pin<br>CDELAY                        | pin ground; charge current                                   | _                   | -2   | _                      | μΑ   |
|                         |  | V <sub>CDELAY</sub> = V <sub>DD</sub> ;<br>discharge current | _                   | 9    | -                      | mA   |
| C <sub>CDELAY</sub>     | capacitor on pin CDELAY                                |  | _                   | 22   | -                      | nF   |
| Crystal osc             | cillator (XTAL1 and XTAL2)                             | ,  |                     | •    | •                      | •    |
| f <sub>XTAL</sub>       | crystal frequency                                      |  | _                   | 12   | _                      | MHz  |
| V <sub>IL</sub>         | LOW-level input voltage on pin XTAL1                   |  | -0.3                | -    | +0.3V <sub>DDD</sub>   | V    |
| V <sub>IH</sub>         | HIGH-level input voltage on pin XTAL1                  |  | 0.7V <sub>DDD</sub> | -    | V <sub>DDD</sub> + 0.3 | V    |
| DC-to-DC c              | onverter   |  | ,                   |      |                        | •    |
| f <sub>clk</sub>        | clock frequency  |  | _                   | 12   | _                      | MHz  |
| V <sub>UP</sub>         | output voltage   | V <sub>CC</sub> = 5 V  | _                   | 5.5  | _                      | V    |
|                         |  | V <sub>CC</sub> = 3 or 1.8 V                                 | _                   | 5    | -                      | V    |
| PE                      | power efficiency                                       | L = 6.8 μH; C = 1 μF   | _                   | 85   | -                      | %    |
| V <sub>DDD</sub> voltag | ge regulator   | ,  |                     | •    | •                      | •    |
| $V_{DDD}$               | output voltage   | PROG = 0   | 3                   | _    | 3.6                    | V    |
|                         |  | PROG = 1 (TDA8030 only)                                      | 4.5                 | _    | 5.5                    | V    |
| I <sub>DDD</sub>        | output current   |  | 0                   | _    | 25                     | mA   |
| C <sub>dec</sub>        | decoupling capacitor                                   | 1  | 1000                |      | _                      | nF   |

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12

55

MHz

V/ns

%

## USB smart card reader (OTP or ROM)

| SYMBOL             | PARAMETER                                       | CONDITIONS   | MIN.                  | TYP. | MAX.            | UNIT |
|--------------------|---|--|-----------------------|------|-----------------|------|
| Reset outp         | ut to the card (RST)                            |  | <b>!</b>              | Į.   | I.              |      |
| V <sub>inact</sub> | output voltage in inactive                      | no load  | 0                     | _    | 0.1             | V    |
|                    | mode  | I <sub>inact</sub> = 1 mA                              | 0                     | _    | 0.3             | V    |
| I <sub>inact</sub> | current from RST when inactive and pin grounded |  | 0                     | -    | -1              | mA   |
| V <sub>OL</sub>    | LOW-level output voltage                        | I <sub>OL</sub> = 200 μA                               | 0                     | -    | 0.3             | V    |
|                    |   | I <sub>OL</sub> = 20 mA                                | V <sub>CC</sub> - 0.4 | _    | V <sub>CC</sub> | V    |
| V <sub>OH</sub>    | HIGH-level output voltage                       | $I_{OH} = -200  \mu A$                                 | 0.9V <sub>CC</sub>    | _    | V <sub>CC</sub> | V    |
|                    |   | $I_{OH} = -20 \text{ mA}$                              | 0                     | _    | 0.4             | V    |
| t <sub>r</sub>     | rise time                                       | C <sub>L</sub> = 100 pF;<br>V <sub>CC</sub> = 5 or 3 V | -                     | -    | 0.1             | μs   |
| t <sub>f</sub>     | fall time                                       | C <sub>L</sub> = 100 pF;<br>V <sub>CC</sub> = 5 or 3 V | -                     | -    | 0.1             | μs   |
| Clock outpo        | ut to the card (CLK)                            |  |                       |      | -               |      |
| V <sub>inact</sub> | output voltage in inactive                      | no load  | 0                     | -    | 0.1             | V    |
|                    | mode  | I <sub>inact</sub> = 1 mA                              | 0                     | _    | 0.3             | V    |
| I <sub>inact</sub> | current from CLK when inactive and pin grounded |  | 0                     | _    | -1              | mA   |
| V <sub>OL</sub>    | LOW-level output voltage                        | I <sub>OL</sub> = 200 μA                               | 0                     | _    | 0.3             | V    |
|                    |   | I <sub>OL</sub> = 70 mA                                | V <sub>CC</sub> - 0.4 | _    | V <sub>CC</sub> | V    |
| V <sub>OH</sub>    | HIGH-level output voltage                       | $I_{OH} = -200  \mu A$                                 | 0.9V <sub>CC</sub>    | _    | V <sub>CC</sub> | V    |
|                    |   | $I_{OH} = -70 \text{ mA}$                              | 0                     | _    | 0.4             | V    |
| t <sub>r</sub>     | rise time                                       | C <sub>L</sub> = 35 pF                                 | _                     | _    | 16              | ns   |
| t <sub>f</sub>     | fall time                                       | C <sub>L</sub> = 35 pF                                 | _                     | -    | 16              | ns   |
| f <sub>clk</sub>   | clock frequency                                 | 1 MHz Idle configuration                               | 1                     | -    | 1.5             | MHz  |

# Card supply voltage ( $V_{CC}$ ) (2 ceramic multilayer capacitors with low ESR of minimum 100 nF should be used in order to meet these specifications)

45

0.2

operational

 $C_L = 35 pF$ 

 $C_{L} = 30 \text{ pF}$ 

| V <sub>inact</sub> | output voltage inactive                                     | no load                   | 0 | _ | 0.1 | V  |
|--------------------|---|---------------------------|---|---|-----|----|
|                    |   | I <sub>inact</sub> = 1 mA | 0 | _ | 0.3 | V  |
| I <sub>inact</sub> | current from V <sub>CC</sub> when inactive and pin grounded |                           | _ | _ | -1  | mA |

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duty factor (except for XTAL)

slew rate (rise and fall)

## USB smart card reader (OTP or ROM)

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| SYMBOL                   | PARAMETER                                       | CONDITIONS   | MIN.                  | TYP. | MAX.            | UNIT |
|--------------------------|---|--|-----------------------|------|-----------------|------|
| V <sub>CC</sub>          | output voltage                                  | active mode;   | 4.75                  | 5    | 5.25            | V    |
|                          |   | I <sub>CC</sub> < 55 mA; 5 V card  |                       |      |                 |      |
|                          |   | active mode;<br>I <sub>CC</sub> < 55 mA; 3 V card  | 2.78                  | 3    | 3.22            | V    |
|                          |   | active mode; current<br>pulses of 40 nAs with<br>I < 200 mA; t < 400 ns;<br>f < 20 MHz; 5 V card   | 4.6                   | -    | 5.4             | V    |
|                          |   | active mode; current<br>pulses of 24 nAs with<br>I < 200 mA; t < 400 ns;<br>f < 20 MHz; 3 V card   | 2.75                  | -    | 3.25            | V    |
|                          |   | active mode;<br>I <sub>CC</sub> < 35 mA; 1.8 V card  | 1.64                  | 1.8  | 1.96            | V    |
|                          |   | active mode; current<br>pulses of 12 nAs with<br>I < 200 mA; t < 400 ns;<br>f < 20 MHz; 1.8 V card | 1.62                  | -    | 1.98            | V    |
| I <sub>CC</sub>          | output current                                  | 5 V card; from 0 to 5 V  | _                     | _    | -55             | mA   |
|                          |   | 3 V card; from 0 to 3 V  | _                     | _    | -55             | mA   |
|                          |   | 1.8 V card; from<br>0 to 1.8 V   | _                     | _    | -35             | mA   |
|                          |   | when clock is stopped; at all V <sub>CC</sub> values   | -                     | -    | -10             | mA   |
|                          |   | V <sub>CC</sub> shorted to ground  | _                     | _    | -120            | mA   |
| SR                       | slew rate                                       | up or down (maximum capacitance = 300 nF)  | 0.05                  | 0.16 | 0.22            | V/μs |
| V <sub>ripple(p-p)</sub> | ripple voltage on V <sub>CC</sub>               | 20 kHz < f < 200 MHz   |                       |      |                 |      |
|                          | (peak-to-peak value)                            | 5 V card   | _                     | _    | 350             | mV   |
|                          |   | 3 V card   | _                     | _    | 200             | mV   |
|                          |   | 1.8 V card   | _                     | _    | 100             | mV   |
| Data line (l/            | O); I/O has an integrated 14                    | $k\Omega$ pull-up resistor at $V_{C}$  | C                     | '    | 1               |      |
| V <sub>inact</sub>       | output voltage inactive                         | no load  | 0                     | _    | 0.1             | V    |
|                          |   | I <sub>inact</sub> = 1 mA  | _                     | _    | 0.3             | V    |
| I <sub>inact</sub>       | current from I/O when inactive and pin grounded |  | _                     | -    | -1              | mA   |
| V <sub>OL</sub>          | LOW-level output voltage                        | the I/O is configured as an output   |                       |      |                 |      |
|                          |   | I <sub>OL</sub> = 1 mA   | 0                     | _    | 0.3             | V    |
|                          |   | I <sub>OL</sub> = 10 mA  | V <sub>CC</sub> – 0.4 | _    | V <sub>CC</sub> | V    |

## USB smart card reader (OTP or ROM)

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| SYMBOL             | PARAMETER  | CONDITIONS   | MIN.                 | TYP.            | MAX.                   | UNIT |
|--------------------|--|--|----------------------|-----------------|------------------------|------|
| V <sub>OH</sub>    | HIGH-level output voltage                                      | the I/O is configured as an output   |                      |                 |                        |      |
|                    |  | I <sub>OH</sub> < -20 μA   | 0.8V <sub>CC</sub>   | _               | V <sub>CC</sub> + 0.25 | V    |
|                    |  | I <sub>OH</sub> < –40 μA;<br>5 and 3 V card  | 0.75V <sub>CC</sub>  |                 | V <sub>CC</sub> + 0.25 | V    |
|                    |  | I <sub>OH</sub> = -10 mA   | 0                    | _               | 0.4                    | V    |
| $V_{IL}$           | LOW-level input voltage  | the I/O is configured as an input  | -0.3                 | -               | +0.8                   | V    |
| $V_{IH}$           | HIGH-level input voltage                                       | the I/O is configured as an input  | 1.5                  | -               | V <sub>CC</sub>        | V    |
| I <sub>IL</sub>    | LOW-level input current on I/O                                 | V <sub>IL</sub> = 0  | _                    | -               | 500                    | μΑ   |
| I <sub>LIH</sub>   | HIGH-level input leakage current on I/O                        | $V_{IH} = V_{CC}$  | _                    | _               | 10                     | μΑ   |
| t <sub>i(tr)</sub> | input transition times   | $C_L \le 60 \text{ pF}$ ; 5 or 3 V card  | _                    | -               | 1.2                    | μs   |
| t <sub>o(tr)</sub> | output transition times  | $C_L \le 60 \text{ pF 5 or 3 V}$ card  | _                    | -               | 0.1                    | μs   |
| R <sub>pu</sub>    | internal pull-up resistance<br>between I/O and V <sub>CC</sub> |  | 11                   | 14              | 17                     | kΩ   |
| t <sub>W(pu)</sub> | width of active pull-up pulse                                  | the I/O is configured as<br>an 2/f <sub>XTAL1</sub> output;<br>LOW-to-HIGH<br>transition | 2/f <sub>XTAL1</sub> | -               | 3/f <sub>XTAL1</sub>   | ns   |
| I <sub>pu</sub>    | current from I/O when active pull-up pulse                     | $V_{OH} = 0.9V_{CC};$ $C_L = 60 \text{ pF}$  | _1                   | -               | _                      | mA   |
| Auxiliary co       | ontacts C4/C8; integrated 10                                   | ${f k}\Omega$ pull-up resistor to ${f V_0}$  | CC                   |                 |                        |      |
| V <sub>inact</sub> | output voltage inactive  | no load  | 0                    | _               | 0.1                    | V    |
|                    |  | I <sub>inact</sub> = 1 mA  | _                    | _               | 0.3                    | V    |
| I <sub>inact</sub> | current from I/O when inactive and pin grounded                |  | -                    | -               | -1                     | mA   |
| V <sub>OL</sub>    | LOW-level output voltage                                       | C4 and C8 configured as an output; I <sub>OL</sub> = 1 mA                                | 0                    | _               | 0.3                    | V    |
| V <sub>ОН</sub>    | HIGH-level output voltage                                      | C4 and C8 configured as an output; I <sub>OH</sub> < –40 μA; 5 and 3 V card              | 0.8V <sub>CC</sub>   | -               | V <sub>CC</sub> + 0.25 | V    |
| V <sub>IL</sub>    | LOW-level input voltage  | C4 and C8 configured -0.3 - +0.8 as an input   |                      | +0.8            | V                      |      |
| V <sub>IH</sub>    | HIGH-level input voltage                                       | C4 and C8 configured 1.5 – V <sub>CC</sub> as an input                                   |                      | V <sub>CC</sub> | V                      |      |
| I <sub>IL</sub>    | LOW-level input current  | V <sub>IL</sub> = 0  | _                    | _               | 500                    | μΑ   |
| I <sub>LIH</sub>   | HIGH-level input leakage current                               | V <sub>IH</sub> = V <sub>CC</sub>  | _                    | -               | 10                     | μΑ   |
|                    | •  |  |                      |                 |                        |      |

## USB smart card reader (OTP or ROM)

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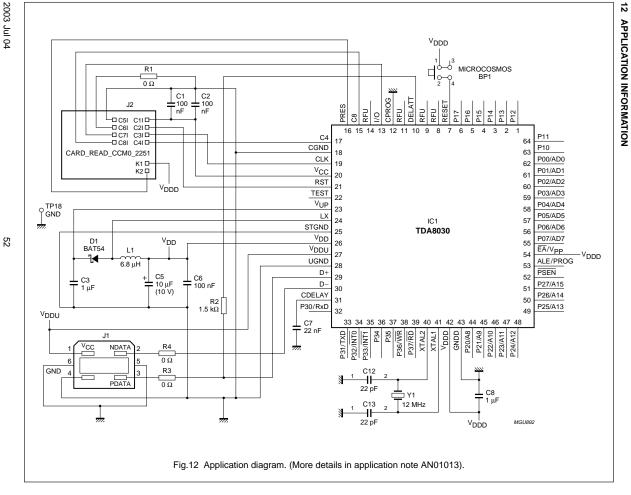
| SYMBOL                | PARAMETER  | CONDITIONS   | MIN.                | TYP. | MAX.                | UNIT |
|-----------------------|--|--|---------------------|------|---------------------|------|
| t <sub>i(tr)</sub>    | input transition times   | C <sub>L</sub> ≤ 60 pF                                     | _                   | _    | 1.2                 | μs   |
| t <sub>o(tr)</sub>    | output transition times  | C <sub>L</sub> ≤ 60 pF                                     |                     | Ī-   | 0.1                 | μs   |
| R <sub>pu</sub>       | internal pull-up resistance<br>between C4/C8 and V <sub>CC</sub>       |  | 8                   |      | 12                  | kΩ   |
| t <sub>W(pu)</sub>    | width of active pull-up pulse  | the I/O is configured as an output; LOW-to-HIGH transition |                     | 200  | _                   | ns   |
| I <sub>pu</sub>       | current from C4 and C8 when active pull-up                             | $V_{OH} = 0.9V_{CC};$ $C_L = 60 \text{ pF}$                | -1                  | _    | _                   | mA   |
| Timing                |  |  | •                   | •    |                     |      |
| t <sub>act</sub>      | activation sequence duration   |  | _                   | T-   | 160                 | μs   |
| t <sub>de</sub>       | deactivation sequence duration   |  | _                   | -    | 100                 | μѕ   |
| Protections           | and limitations  |  |                     | !    | •                   |      |
| I <sub>CC(sd)</sub>   | shutdown and limitation current at V <sub>CC</sub>                     |  | _                   | -100 | -                   | mA   |
| I <sub>I/O(lim)</sub> | limitation current on I/O  |  | -10                 | -    | +10                 | mA   |
| I <sub>CLK(lim)</sub> | limitation current on pin CLK -70                                      |  | -                   | +70  | mA                  |      |
| I <sub>RST(lim)</sub> | limitation current on pin RST -20                                      |  | -                   | +20  | mA                  |      |
| I <sub>RST(sd)</sub>  | shutdown current on pin<br>RST   | •  |                     | -20  | _                   | mA   |
| T <sub>sd</sub>       | shutdown temperature –   |  | 150                 | _    | °C                  |      |
| Card prese            | nce input; pin PRES  |  |                     |      |                     |      |
| V <sub>IL</sub>       | LOW-level input voltage  |  | _                   | -    | 0.3V <sub>DDD</sub> | V    |
| V <sub>IH</sub>       | HIGH-level input voltage 0.7V <sub>DDD</sub>                           |  | 0.7V <sub>DDD</sub> | -    | _                   | V    |
| I <sub>IL</sub>       | input leakage current low $V_{IN} = 0$ -                               |  | _                   | -    | ±20                 | μΑ   |
| I <sub>IH</sub>       | input leakage current high   | $V_{IN} = V_{DD}$  | _                   | Ī-   | ±20                 | μΑ   |
| General pu            | rpose I/Os; pins P0X, P1X, P2  | X and P3X  | •                   | •    | •                   | •    |
| V <sub>IL</sub>       | LOW-level input voltage  |  | _                   | T-   | 0.2V <sub>DDD</sub> | V    |
| V <sub>IH</sub>       | · · · ·  |  | $0.2V_{DDD} + 0.9$  | -    | _                   | V    |
| V <sub>OL</sub>       | LOW-level output voltage I <sub>OL</sub> = 1.6 mA -                    |  | -                   | 0.4  | V                   |      |
| V <sub>OH</sub>       | HIGH-level output voltage  |  |                     | -    | _                   | V    |
| I <sub>IL</sub>       | LOW-level input current  |  |                     | -50  | μΑ                  |      |
| I <sub>TL</sub>       | HIGH-to-LOW transition $V_I = 2 V$ — current                           |  | _                   | -650 | μΑ                  |      |
| Pins ALE a            | nd PSEN  |  |                     |      |                     |      |
| V <sub>OL</sub>       | LOW-level output voltage I <sub>OL</sub> = 3.2 mA                      |  | _                   | _    | 0.4                 | V    |
| V <sub>OH</sub>       | HIGH-level output voltage $I_{OH} = -3.2 \text{ mA}$ $V_{DDD} - 0.7$ - |  | _                   | V    |                     |      |
|                       |  |  |                     |      |                     |      |

## USB smart card reader (OTP or ROM)

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| SYMBOL                 | PARAMETER   | CONDITIONS                                  | MIN.                      | TYP.  | MAX.                | UNIT |
|------------------------|---|---|---------------------------|-------|---------------------|------|
| Pin EA/V <sub>PP</sub> |   |   | 1                         | 1     | ·                   | '    |
| V <sub>IL</sub>        | LOW-level input voltage   |   | _                         | _     | 0.2V <sub>DDD</sub> | V    |
| V <sub>IH</sub>        | HIGH-level input voltage  |   | 0.2V <sub>DDD</sub> + 0.9 | _     | _                   | V    |
| V <sub>prog</sub>      | programming voltage   | TDA8030                                     | 12.5                      | 12.75 | 13                  | V    |
| Reset input            | ; pin RESET (active HIGH)   |   |                           | •     | •                   | •    |
| V <sub>IL</sub>        | LOW-level input voltage   |   | _                         | _     | 0.2V <sub>DDD</sub> | V    |
| V <sub>IH</sub>        | HIGH-level input voltage  |   | 0.7V <sub>DDD</sub>       | -     | -                   | V    |
| DELATT out             | tput pin; optional connection                                       | for an external 1.5 k $\Omega$ r            | esistor on pin D          | )+    | •                   | •    |
| V <sub>OH</sub>        | HIGH-level output voltage   | when switched on;<br>I <sub>OH</sub> = 2 mA | 3.0                       | _     | 3.6                 | V    |
| IL                     | leakage current   | when switched off                           | _                         | -     | 10                  | μΑ   |
| Programmii             | ng input; pin PROG (active H  | IGH) and Test input; pin                    | TEST (active H            | IGH)  | •                   | •    |
| V <sub>IL</sub>        | LOW-level input voltage   |   | _                         | _     | 0.2V <sub>DD</sub>  | V    |
| V <sub>IH</sub>        | HIGH-level input voltage  |   | 0.7V <sub>DD</sub>        | -     | _                   | V    |
| ATX Transc             | eiver   |   |                           | •     |                     | •    |
| DRIVER CHAP            | RACTERISTICS IN FULL-SPEED MO                                       | DE; PINS D+ AND D-                          |                           |       |                     |      |
| V <sub>OL(stat)</sub>  | LOW-level static output voltage                                     | $R_L = 1.5 \text{ k}\Omega$                 | _                         | -     | 0.3                 | V    |
| V <sub>OH(stat)</sub>  | HIGH-level static output voltage                                    |   | 2.8                       | -     | 3.6                 | V    |
| R <sub>o(drive)</sub>  | driver output resistance  | excluding outside resistors                 | 10                        | -     | 30                  | Ω    |
| t <sub>tr</sub>        | transition times  | C <sub>L</sub> = 50 pF                      | 4                         | -     | 20                  | ns   |
| t <sub>RFM</sub>       | rise and fall time matching   | C <sub>L</sub> = 50 pF                      | 90                        | -     | 110                 | %    |
| V <sub>cross</sub>     | output signal crossover voltage                                     |   | 1.3                       | -     | 2                   | V    |
| R <sub>int(DP)</sub>   | integrated resistor on DP   | when connected USB_SOFTCONNECT active       | 1.1                       | -     | 1.9                 | kΩ   |
| RECEIVER CH            | HARACTERISTICS IN FULL-SPEED N                                      | MODE; PINS ATXDP AND AT                     | XDM                       |       |                     | -    |
| $V_{i(dif)}$           | differential input sensitivity                                      |   | 0.2                       | -     | _                   | V    |
| V <sub>dif(CM)</sub>   | differential common mode range in which V <sub>i(dif)</sub> applies |   | 0.8                       | _     | 2.5                 | V    |
| $V_{th(SE)}$           | single-ended receiver<br>threshold                                  |   | 0.8                       | _     | 2.0                 | V    |
|                        | 1   | <u> </u>                                    | 1                         |       |                     |      |

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USB smart card reader (OTP or ROM)

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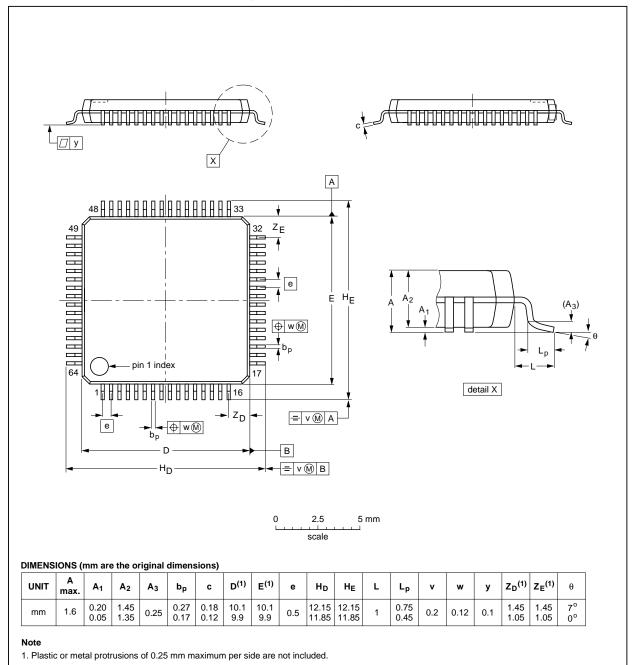
### USB smart card reader (OTP or ROM)

TDA8030; TDA8031

### 13 PACKAGE OUTLINE

LQFP64: plastic low profile quad flat package; 64 leads; body 10 x 10 x 1.4 mm

SOT314-2



| OUTLINE |          | REFERENCES |        |       | EUROPEAN | ISSUE DATE |                                 |
|---------|----------|------------|--------|-------|----------|------------|---------------------------------|
|         | VERSION  | IEC        | JEDEC  | JEITA |          | PROJECTION | ISSUE DATE                      |
|         | SOT314-2 | 136E10     | MS-026 |       |          |            | <del>00-01-19</del><br>03-02-25 |

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#### 14 SOLDERING

## 14.1 Introduction to soldering surface mount packages

This text gives a very brief insight to a complex technology. A more in-depth account of soldering ICs can be found in our "Data Handbook IC26; Integrated Circuit Packages" (document order number 9398 652 90011).

There is no soldering method that is ideal for all surface mount IC packages. Wave soldering can still be used for certain surface mount ICs, but it is not suitable for fine pitch SMDs. In these situations reflow soldering is recommended.

### 14.2 Reflow soldering

Reflow soldering requires solder paste (a suspension of fine solder particles, flux and binding agent) to be applied to the printed-circuit board by screen printing, stencilling or pressure-syringe dispensing before package placement. Driven by legislation and environmental forces the worldwide use of lead-free solder pastes is increasing.

Several methods exist for reflowing; for example, convection or convection/infrared heating in a conveyor type oven. Throughput times (preheating, soldering and cooling) vary between 100 and 200 seconds depending on heating method.

Typical reflow peak temperatures range from 215 to 270 °C depending on solder paste material. The top-surface temperature of the packages should preferably be kept:

- below 220 °C (SnPb process) or below 245 °C (Pb-free process)
  - for all BGA and SSOP-T packages
  - for packages with a thickness ≥ 2.5 mm
  - for packages with a thickness < 2.5 mm and a volume ≥ 350 mm<sup>3</sup> so called thick/large packages.
- below 235 °C (SnPb process) or below 260 °C (Pb-free process) for packages with a thickness < 2.5 mm and a volume < 350 mm<sup>3</sup> so called small/thin packages.

Moisture sensitivity precautions, as indicated on packing, must be respected at all times.

### 14.3 Wave soldering

Conventional single wave soldering is not recommended for surface mount devices (SMDs) or printed-circuit boards with a high component density, as solder bridging and non-wetting can present major problems. To overcome these problems the double-wave soldering method was specifically developed.

If wave soldering is used the following conditions must be observed for optimal results:

- Use a double-wave soldering method comprising a turbulent wave with high upward pressure followed by a smooth laminar wave.
- For packages with leads on two sides and a pitch (e):
  - larger than or equal to 1.27 mm, the footprint longitudinal axis is preferred to be parallel to the transport direction of the printed-circuit board;
  - smaller than 1.27 mm, the footprint longitudinal axis must be parallel to the transport direction of the printed-circuit board.

The footprint must incorporate solder thieves at the downstream end.

 For packages with leads on four sides, the footprint must be placed at a 45° angle to the transport direction of the printed-circuit board. The footprint must incorporate solder thieves downstream and at the side corners.

During placement and before soldering, the package must be fixed with a droplet of adhesive. The adhesive can be applied by screen printing, pin transfer or syringe dispensing. The package can be soldered after the adhesive is cured.

Typical dwell time of the leads in the wave ranges from 3 to 4 seconds at 250 °C or 265 °C, depending on solder material applied, SnPb or Pb-free respectively.

A mildly-activated flux will eliminate the need for removal of corrosive residues in most applications.

### 14.4 Manual soldering

Fix the component by first soldering two diagonally-opposite end leads. Use a low voltage (24 V or less) soldering iron applied to the flat part of the lead. Contact time must be limited to 10 seconds at up to 300 °C.

When using a dedicated tool, all other leads can be soldered in one operation within 2 to 5 seconds between 270 and 320 °C.

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### 14.5 Suitability of surface mount IC packages for wave and reflow soldering methods

| PACKAGE <sup>(1)</sup>   | SOLDERING METHOD                  |                       |  |
|--|-----------------------------------|-----------------------|--|
| PACKAGE  | WAVE                              | REFLOW <sup>(2)</sup> |  |
| BGA, LBGA, LFBGA, SQFP, SSOP-T <sup>(3)</sup> , TFBGA, VFBGA             | not suitable                      | suitable              |  |
| DHVQFN, HBCC, HBGA, HLQFP, HSQFP, HSOP, HTQFP, HTSSOP, HVQFN, HVSON, SMS | not suitable <sup>(4)</sup>       | suitable              |  |
| PLCC <sup>(5)</sup> , SO, SOJ  | suitable                          | suitable              |  |
| LQFP, QFP, TQFP  | not recommended <sup>(5)(6)</sup> | suitable              |  |
| SSOP, TSSOP, VSO, VSSOP  | not recommended <sup>(7)</sup>    | suitable              |  |

#### **Notes**

- For more detailed information on the BGA packages refer to the "(LF)BGA Application Note" (AN01026); order a copy from your Philips Semiconductors sales office.
- 2. All surface mount (SMD) packages are moisture sensitive. Depending upon the moisture content, the maximum temperature (with respect to time) and body size of the package, there is a risk that internal or external package cracks may occur due to vaporization of the moisture in them (the so called popcorn effect). For details, refer to the Drypack information in the "Data Handbook IC26; Integrated Circuit Packages; Section: Packing Methods".
- 3. These transparent plastic packages are extremely sensitive to reflow soldering conditions and must on no account be processed through more than one soldering cycle or subjected to infrared reflow soldering with peak temperature exceeding 217  $^{\circ}$ C  $\pm$  10  $^{\circ}$ C measured in the atmosphere of the reflow oven. The package body peak temperature must be kept as low as possible.
- 4. These packages are not suitable for wave soldering. On versions with the heatsink on the bottom side, the solder cannot penetrate between the printed-circuit board and the heatsink. On versions with the heatsink on the top side, the solder might be deposited on the heatsink surface.
- 5. If wave soldering is considered, then the package must be placed at a 45° angle to the solder wave direction. The package footprint must incorporate solder thieves downstream and at the side corners.
- 6. Wave soldering is suitable for LQFP, TQFP and QFP packages with a pitch (e) larger than 0.8 mm; it is definitely not suitable for packages with a pitch (e) equal to or smaller than 0.65 mm.
- 7. Wave soldering is suitable for SSOP, TSSOP, VSO and VSSOP packages with a pitch (e) equal to or larger than 0.65 mm; it is definitely not suitable for packages with a pitch (e) equal to or smaller than 0.5 mm.

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#### 15 DATA SHEET STATUS

| LEVEL | DATA SHEET<br>STATUS <sup>(1)</sup> | PRODUCT<br>STATUS <sup>(2)(3)</sup> | DEFINITION   |
|-------|-------------------------------------|-------------------------------------|--|
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#### **Contact information**

For additional information please visit http://www.semiconductors.philips.com. Fax: +31 40 27 24825 For sales offices addresses send e-mail to: sales.addresses@www.semiconductors.philips.com.

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